Toshiba Personal Computer Satellite A70 Maintenance Manual

TOSHIBA CORPORATION

Copyright

© 2004 by Toshiba Corporation. All rights reserved. Under the copyright laws, this manual cannot be reproduced in any form without the prior written permission of Toshiba. No patent liability is assumed with respect to the use of the information contained herein.

Toshiba Personal Computer Satellite SATELLITE A70 Maintenance Manual

First edition September 2004

Disclaimer

The information presented in this manual has been reviewed and validated for accuracy. The included set of instructions and descriptions are accurate for the A70 Series at the time of this manual's production. However, succeeding computers and manuals are subject to change without notice. Therefore, Toshiba assumes no liability for damages incurred directly or indirectly from errors, omissions, or discrepancies between any succeeding product and this manual.

Trademarks

IBM is a registered trademark, and OS/2 and PS/2 are trademarks of IBM Corporation. Microsoft, MS-DOS, Windows, DirectSound and DirectMusic are registered trademarks of Microsoft Corporation.

Intel and Pentium are registered trademarks, and SpeedStep is a trademark of Intel Corporation. Sound Blaster is a registered trademark of Creative Technology Ltd.

Centronics is a registered trademark of Centronics Data Computer Corporation.

Photo CD is a trademark of Eastman Kodak.

All other properties are trademarks or registered trademarks of their respective holders.

Preface

This maintenance manual describes how to perform hardware service maintenance for the Toshiba Personal Computer Satellite SATELLITE A70/A75, referred to as the A70 Series in this manual.

The procedures described in this manual are intended to help service technicians isolate faulty Field Replaceable Units (FRUs) and replace them in the field.

SAFETY PRECAUTIONS

Four types of messages are used in this manual to bring important information to your attention. Each of these messages will be italicized and identified as shown below.

DANGER: "Danger" indicates the existence of a hazard that could result in death or serious bodily injury if the safety instruction is not observed.

WARNING: "Warning" indicates the existence of a hazard that could result in bodily injury if the safety instruction is not observed.

CAUTION: "Caution" indicates the existence of a hazard that could result in property damage if the safety instruction is not observed.

NOTE: "Note" contains general information that relates to your safe maintenance service.

Improper repair of the computer may result in safety hazards. Toshiba requires service technicians and authorized dealers or service providers to ensure the following safety precautions are adhered to strictly.

- □ Be sure to fasten screws securely with the right screwdriver. If a screw is not fully fastened, it could come loose, creating a danger of a short circuit, which could cause overheating, smoke or fire.
- □ If you replace the battery pack or RTC battery, be sure to use only the same model battery or an equivalent battery recommended by Toshiba. Installation of the wrong battery can cause the battery to explode.

The manual is divided into the following parts:

Chapter 1	Hardware Overview describes the A70 Series system unit and each FRU
Chapter 2	Troubleshooting Procedures explains how to diagnose and resolve FRU problems.
Chapter 3	Test and Diagnostics describes how to perform test and diagnostic operations for maintenance service.
Chapter 4	Replacement Procedures describes the removal and replacement of the FRUs.
Appendices	The appendices describe the following:

- Handling the LCD module
 Board layout
 Pin assignments

- □ Keyboard scan/character codes
- □ Key layout
- Reliability

Conventions

This manual uses the following formats to describe, identify, and highlight terms and operating procedures.

Acronyms

On the first appearance and whenever necessary for clarification acronyms are enclosed in parentheses following their definition. For example:

Read Only Memory (ROM)

Keys

Keys are used in the text to describe many operations. The key top symbol as it appears on the keyboard is printed in **boldface** type.

Key operation

Some operations require you to simultaneously use two or more keys. We identify such operations by the key top symbols separated by a plus (+) sign. For example, **Ctrl + Pause (Break)** means you must hold down **Ctrl** and at the same time press **Pause (Break)**. If three keys are used, hold down the first two and at the same time press the third.

User input

Text that you are instructed to type in is shown in the boldface type below:

DISKCOPY A: B:

The display

Text generated by the computer that appears on its display is presented in the type face below:

```
Format complete
System transferred
```

Table of Contents

Chapter 1 Hardware Overview

1.1	Features	1-1
1.2	System Unit	1-5
1.3	2.5-inch Hard Disk Drive	1-9
1.4	Removable Drives	1-10
1.5	Power Supply	1-16
1.6	Batteries	1-18

Chapter 2 Troubleshooting Procedures

2.1	Troubleshooting Introduction	
2.2	Troubleshooting Flowchart	
2.3	Power Supply Troubleshooting	
2.4	Display Troubleshooting	
2.5	Keyboard Troubleshooting	
2.6	External USB Devices Troubleshooting	
2.7	TV-Out Failure Troubleshooting	
2.8	Printer Port Troubleshooting	
2.9	TouchPad Troubleshooting	
2.10	Speaker Troubleshooting	
2.11	Optical Drive Troubleshooting	
2.12	Modem Troubleshooting	
2.13	PCMCIA Troubleshooting	
2.14	IEEE 1394 Troubleshooting	2-34
2.15	Wireless LAN Troubleshooting	

Chapter 3 Tests and Diagnostics

3.1	The Diagnostic Test	3-1
3.2	Executing the Diagnostic Test	3-2
3.3	Config Check Test	3-6
3.4	DMI Check Test	3-7
3.5	PIO Loopback Test	3-8
3.6	IEEE 1394 Test	3-9
3.7	Speaker Audio Test	3-10
3.8	Fan ON/OFF Test	3-11
3.9	Main Battery Charge Test	3-12
3.10	FDD Test	3-13
3.11	CD-ROM Test	3-14
3.12	Keyboard Test	3-15
3.13	Mouse (Pad) Test	3-17
3.14	LCD Pixels Mode Test	3-19
3.15	Lid Switch Test	3-20
3.16	HDD R/W Test	3-21
3.17	LAN Test	3-23
3.18	RTC Test	3-25
3.19	CD Control Button Test	3-26

Chapter 4 Replacement Procedures

4.1	General	
4.2	Battery	
4.3	PC Card	
4.4	HDD	
4.5	Optical Drive Module	
4.6	Optical Drive	
4.7	Wireless LAN Unit	
4.8	Expansion Memory	
4.9	Keyboard	
4.10	Modem	
4.11	Display Assembly	
4.12	Touch Cover	
4.13	Touch Pad	
4.14	Speakers	
4.15	System Board	
4.16	Fan, Heat Sink, & CPU	
4.17	Display Mask	
4.18	LCD Module	4-44
4.19	FL Inverter Board	4-47

Appendices

Appendix A	Handling the LCD Module	A-1
Appendix B	Board Layout	B-1
Appendix C	Pin Assignments	C-1
Appendix D	Keyboard Scan/Character Codes	D-1
Appendix E	Key Layout	E-1
Appendix F	Series Screw Torque List	F-1
Appendix G	Reliability	G-1

Chapter 1

Hardware Overview

Chapter 1 Contents

Features1-1		
System Unit1-		
2.5-inch Hard Disk Drive1-		
Removable Drives1		
1.4.1	DVD-R/-RW Drive	
1.4.2	DVD-ROM Drive	
1.4.3	DVD+-R/DVD+-RW Drive	1-14
1.4.4	DVD Super Multi Drive	1-15
Power S	upply	1-16
Batteries	S	1-18
1.6.1	Main Battery	
1.6.2	RTC battery	1-19
	System 2.5-inch Remova 1.4.1 1.4.2 1.4.3 1.4.4 Power S Batteries 1.6.1	System Unit

1.1 Features

The Satellite A70 Series Personal Computer uses extensive Large Scale Integration (LSI), and Complementary Metal-Oxide Semiconductor (CMOS) technology extensively to provide compact size, minimum weight and high reliability. This computer incorporates the following features and benefits:

□ CPU

- Intel[®] Celeron[®] Processor up to 2.8 GHz
- Mobile Intel[®] Pentium[®] 4 Processor up to 3.06GHz
- Mobile Intel[®] Pentium[®] 4 Processor up to 3.2GHz supporting HT Technology
- Mobile Intel[®] Pentium[®] 4 Processor up to 538 or higher supporting HT Technology
- Micro FC-PGA package CPU

□ Chipset

- ATI Mobility RadeonTM 9000IGP
- ATI IXP150
- ENE KB910 for Keyboard Controller, Battery management Unit, and RTC.
- ENE CB1410 for Card Bus PCMCIA controller or CB714 for Card Bus PCMCIA controller with Multiple Digital Media Card Slot
- ALC250 for AC97 CODEC.
- TI TSB43AB21A for IEEE 1394 controller.
- Realtek RTL8100CL on board LAN.
- □ Memory
 - On board memory with 256MB or 512 MB supporting.
 - Maximum system memory up to 1.5GB (one 1GB SO-DIMM module and 512MB on board RAM).
 - 128KB L2 Cache (Intel[®] Celeron[®] Processor up to 2.8GHz)
 - 512KB L2 Cache (Mobile Intel[®] Pentium[®] 4 Processor up to 3.2GHz)
 - 1MB L2 Cache (Mobile Intel[®]Pentium[®] 4 Processor up to 538 or higher)
 - 16, 32, 64 or 128 MB of system memory is provided for video display

D BIOS

- 512KB Flash ROM for system BIOS.
- Suspend to RAM/Disk.
- Password protection (System).
- Various hot key for system control.
- Refreshable
- Complete ACPI 1.0b Function
- D Power
 - 12-cell Li-Ion smart battery pack with 14.8V*6450mAh capacity or 8-cell Li-Ion smart battery pack with 14.8V*4300mAh capacity (depending on the models)
 - Approximately 12 hours or longer charging time to 100% battery capacity (system on).
 - Approximately 4 hours charge time to 100% battery capacity (system off)
 - Approximately 2.6 days discharge time in standby mode for 12-cell battery and 1.7 days for 8-cell battery.
 - Discharge time in shutdown mode is approximately 1 month.

□ HDD

- One 2.5", 9.5mm hard disk with capacity 30GB/40GB/60GB/80GB
- Bus Master IDE
- 9.5mm, 2.5"HDD Support
- Support Ultra 100 synchronous DMA

ODD Devices

One of the following:

- 5.25" 12.7mm height DVD-ROM drive
- 5.25" 12.7mm height CD-RW/DVD-ROM drive
- 5.25" 12.7mm height DVD-R/-RW drive
- 5.25" 12.7mm height DVD±R/±RW drive
- 5.25" 12.7mm height DVD Super Multi drive
- Optional Devices
 - PC2700 256MB/512MB/1GB SO-DIMM modules
 - MINI PCI module(802.11g,802.11a+g wireless LAN module)
- □ Keyboard

An easy-to-use 87-key keyboard provides a numeric keypad overlay for fast numeric data entry or for cursor and page control. It supports software that uses a 101- or 102-key enhanced keyboard. Includes one Windows[®] key and one Application key.

□ TouchPad

This pointing control device, located in the center of the keyboard palm-rest, provides convenient control of the cursor without requiring desk space for a mouse. The TouchPad incorporates two mouse buttons.

Display

- 15.4-inch WXGA TFT screen, 1280×800 pixels, Response time 50ms (typ.); For Normal LCD-Contrast ratio 300:1 (typ.); Brightness 168 Nit (typ.)
- 15.4-inch WXGA TFT screen, 1280×800 pixels, Response time 50ms (typ.); For Hight brightness CSV-Contrast ratio 600:1 (typ.); Brightness 220 Nit(typ.)
- □ I/O Ports
 - One 25 pins Parallel port, EPP/ECP Capability
 - One 15 pins CRT port, Support DDC 2B
 - One TV-out connector
 - One MIC In port
 - One headphone-out
 - One 2pins AC Adapter Jack
 - One type II PCMCIA Card Bus slots
 - Three 4 pins USB ports
 - One RJ11/RJ45 Port
 - VR for volume control
 - IrDA Port
 - 1394 Port
 - Multiple Digital Media Card Slot (SD/MMC/SM/MS/MS Pro/xD)
 - One 10/100T Ethernet Port
- D PCMCIA Card Organization
 - One type II card socket only
 - SRAM, OTPROM, FLASH ROM
 - Mask ROM memory card
 - MODEM/LAN card
 - Card bus card
 - PC Card 8.0 Compliant, supports 3V and 5V cards
- D Multiple Digital Media Card
 - Supports SD/MMC/SM/MS/MS Pro/xD card
 - SD memory capacity support from 8MB to 512MB
 - MMC memory capacity support from 8MB to 256MB
 - SM memory capacity support from 4MB to 128MB
 - MS memory capacity support from 8MB to 256MB
 - MS Pro memory capacity support from 256MB to 1GB
 - xD memory capacity support from 4MB to 512MB

□ Universal Serial Bus (USB)

The computer comes with three USB ports that comply with Universal Host Controller Interface (UHCI). The USB enables daisy-chain connection of up to 127 USB-equipped devices. It is designed for easy configuration by a Plug-and-Play operating system and provides hot insertion/ejection capability.

□ Parallel port

A 25-pin parallel port enables connection of a printer or other parallel device. The port supports Extended Capabilities Port (ECP) conforming to IEEE-1284 and is Enhanced Parallel Port (IEEE 1284) compliant. It features ChiProtect circuitry for protection against damage due to printer power-on.

□ External monitor port

A 15-pin CRT port supporting DDC 2B enables connection of an external monitor, which is recognized automatically by Video Electronics Standards Association (VESA) Display Data Channel (DDC) compatible functions.

□ Sound system

A Cirrus logic ALC250 for AC97 codec audio subsystem offers industry leading mixed signal technology to enhance the computer's multimedia capability. The sound system is equipped with stereo speakers and jacks for headphone and external microphone.

□ TV-out port

This video-out mini-jack enables transfer of NTSC or PAL data (video and right/left audio) to external devices such as a TV.

□ LAN port

The computer comes with an RJ-45 Local Area Network (LAN) port. The LAN port provides connectivity for LAN.

□ Programmable button

When system is off, pressing this button will turn on CD Playback mode. Pressing this button again will turn off CD Playback mode. When system is turned on, pressing this button will launch the program which you defined with Programmable Button utility.(The default setting is Windows Media Player)

1.2 System Unit

The system unit is composed of the following major components:

□ Processor

- Intel[®] Celeron[®] Processor up to 2.8 GHz
- Mobile Intel[®] Pentium[®] 4 Processor up to 3.06GHz
- Mobile Intel[®] Pentium[®] 4 Processor up to 3.2GHz supporting HT Technology
- Mobile Intel[®] Pentium[®] 4 Processor up to 538 or higher supporting HT Technology
- Micro FC-PGA package CPU
- □ System Logic
 - ATI Mobility RADEON™ 9000IGP/216CLS3BGA21H
 - Integrated DRAM controller
 - Hub Interface to ATI IXP150/218S2EBNA43
 - Power Management Functions
- □ Keyboard Controller
 - KB910 is use as keyboard controller and battery management unit
- □ Memory
 - System DRAM
 - One JEDEC standard 200-pins DDR SO-DIMM memory support +2.5V PC2700 128/256/512MB/1024MB.
 - System & KB Combine ROM BIOS
 - 512KB Flash ROM
- □ Video Subsystem (ATI Mobility RADEONTM)
 - UMA VGA Memory up to 128MB
 - Display Core Frequency of 200/250/266/333MHZ
 - 3D Graphics Engine
 - Analog Display support
 - Digital Video out port(DVOB and DVOC)support
 - DVOB With 165-MHZ clot clock support for 12 bit interface.
 - Dedicated 2FP(local flat panel) interface
 - Single or dual channel LVDS panel support up to WXGA panel, resolution with frequency range from 25MHZ to 112MHZ per channel.
- SMsC LPC 47N217 Super I/O with LPC Interface
 - PC99a, PC2001
 - ACPI 2.0 Compliant

- Serial Ports
- One Full Function Serial Port
- High Speed NS 16C550A Compatible UARTs with Send/Receive 16-Byte FIFO
- Supports 230k and 460k Baud
- Programmable Baud Rate Generator
- Modem Control Circuitry
- Infrared Communications Controller
- IrDA v1.2 (4Mbps), HPSIR, ASKIR, Consumer IR Support
- 1 IR Ports
- 96 Base I/O Address, 15 IRQ Options and 3 DMA Options
- Multi-Mode Parallel Port with ChiProtect
- Standard Mode IBM PC/XT , PC/AT, and PS/2 Compatible Bidirectional Parallel Port
- Enhanced Parallel Port (EPP) Compatible – EPP 1.7 and EPP 1.9 (IEEE 1284 Compliant)
- IEEE 1284 Compliant Enhanced Capabilities Port (ECP)
- ChiProtect Circuitry for Protection Against Damage Due to Printer Power-On
- 192 Base I/O Address, 15 IRQ and 3 DMA Options
- LPC Bus Host Interface
- Multiplexed Command, Address and Data Bus
- 8-Bit I/O Transfers
- 8-Bit DMA Transfers
- 16-Bit Address Qualifiation
- Serial IRQ Interface Compatible with Serialized Serial IRQ Interface Compatible with Serialized IRQ Support for PCI Systems
- PCI CLKRUN# Support
- Power Management Event (IO_PME#) Interface Pin

□ Audio subsystem

- Realtek ALC250 for AC97 codec
 - AC 97 2.2 Compatible.
 - Industry Leading Mixed Signal Technology.
 - 20-bit Stereo Digital-to-Analog Converters.
 - 18-bit Stereo Analog-to- Digital Converters.
 - Sample Rate Converters.
 - Four Analog Line-level Stereo Inputs for LIN_IN, CD, VIDEO, and AUX.
 - Two Analog Line-level Mono Inputs for Modem and Internal PC Beep.
 - Dual Stereo Line-level Outputs for LINE_OUT and ALT_LINE_OUT.
 - Dual Microphone Inputs.
 - High Quality Differential CD Input.

- Extensive Power Management Support.
- Meets or Exceeds the Microsoft® PC 99 Audio & WLP2.0 audio Requirements.
- S/PDIF Digital Audio Output.
- 3D Stereo Enhancement.
- Support double sampling rate (96KHz) of DVD audio playback.
- □ ENE CB714 Card Bus Host Adapter
 - 3.3V Operation with I/O 5V Tolerance
 - LFBGA 169-ball Package
 - Pinout Compatible with CB1410.
 - PCI Interface
 - Compliant with PCI Local Bus Specification Revision 2.3
 - Compliant with PCI Bus Power Management Interface Specification Revision 1.1
 - Compliant with PCI Mobile Design Guide Version 1.1
 - Compliant with Advanced Configuration and Power Interface Specification Revision 1.0
 - CardBus Interface
 - Compliant with PC Card Standard 8.0
 - Support Standardized Zoomed Video Register Model
 - Support SPKROUT CAUDIO and RIOUT#
 - Secure Digital Interface
 - Compliant with SD Host Controller Standard Specification Version 1.0
 - Support SD Suspend/Resume Functionality
 - Support DMA Mode to Minimize CPU Overhead
 - Support High Speed with the SD Clock Frequency Up to 50Mhz
 - Contain two 512-byte buffer to maximize the transfer speed
 - Support Traffic LED Light
 - Support Over Current Protection
 - Secure Digital Interface
 - Compliant with SD Host Controller Standard Specification Version 1.0
 - Support SD Suspend/Resume Functionality
 - Support DMA Mode to Minimize CPU Overhead
 - Support High Speed with the SD Clock Frequency Up to 50Mhz

- - Contain two 512-byte buffer to maximize the transfer speed
- – Support Traffic LED Light
- – Support Over Current Protection

1.3 2.5-inch Hard Disk Drive

The internal HDD is a random access non-volatile storage device. It has a non-removable 2.5-inch magnetic disk and mini-Winchester type magnetic heads. The computer supports a 30 / 40 / 60 / 80GB HDD.

1.4 Removable Drives

The module compartments can accommodate the following removable modules:

- DVD-R/-RW drive
- DVD-ROM drive
- CD-RW/DVD-ROM drive
- DVD+-R/+-RW drive
- DVD Super Multi ddrive

1.4.1 DVD-R/-RW Drive

The DVD-R/-RW drive (Toshiba SD-R6112) accommodates either 12cm (4.72-inch) or 8cm (3.15-inch) CDs or DVDs.

Read speeds

DVD-ROM	Maximum 8 times faster rotational speed
DVD-RAM	Standard rotational speed
CD-ROM	Maximum 24 times faster rotational speed

Write speeds

CD-R	4,16 times faster rotational speed
CD-RW	4 times faster rotational speed
High-Speed CD-RW	4,10 times faster rotational speed
DVD-R	1, 2 times rotational speed
DVD-RW disc	1 times rotational speed

Access Speed

Average Random Access Time	DVD-ROM: CD-ROM: DVD-RAM:	115 ms (3.3-8X) 105 ms (10.3-24X) 170 ms (4.7GB 1X)
Average Random Seek Time	DVD-ROM: CD-ROM: DVD-RAM:	105 ms (3.3-8X) 100 ms (10.3-24X) 120 ms (4.7GB 1X)
Average Full Stroke Access Time	DVD-ROM: CD-ROM: DVD-RAM:	195 ms (3.3-8X) 180 ms (10.3-24X) 350 ms (4.7GB 1X)
Buffer capacity	2 Mbytes (Ma	ux)

Supported formats

Applicable	CD	CD-R/RW
Write Formats:	DVD	DVD-R DVD-RW
Applicable Write Disc:	CD	CD-R/RW [CD-DA, CD+(E)G, CD-MIDI, CD-ROM, CD-ROM XA, MIXED MODE CD, CD-I, CD-I Bridge (Photo-CD, Video-CD), Multisession CD (Photo-CD, CD-EXTRA, Portfolio)]
	DVD	DVD-RW DVD-R
Applicable Read Disc:	CD	CD-DA, CD+(E)G, CD-MIDI, CD-TEXT, CD-ROM, CD-ROM XA, CD-I, CD-I Bridge (Photo-CD, Video-CD) Multisession CD (Phto-CD, CD-EXTRA, CD-R, CD-RW, Portfolio), CD-R, CD-RW
	DVD	DVD-ROM [DVD-5, DVD-9, DVD-10, DVD-18] DVD-R DVD-RW DVD-RAM

1.4.2 DVD-ROM Drive

The DVD-ROM drive (Toshiba SD-C2612 or Matsushita SR-8177) accommodates either 12cm (4.72-inch) or 8cm (3.15-inch) CDs or DVDs.

Transfer rates

Matsushita SR-8177:	The DVD-ROM drive is able to read CD-ROM, CD-R data at 10.3X to
	24X CAV mode speed and CD-RW data at 5.1X to 12X CAV mode speed.
	The drive has a transfer rate of max. 3 600 kbyte/s for CD-ROM data, CD-
	R and max. 1 800 kbyte/s for CD-RW data. The drive is able to read DVD
	disc at CAV mode speed. The drive has a transfer rate of max. 11.08
	Mbyte/s for DVD data.
	•

Toshiba SD-C2612: Max.8X (DVD-ROM) / Max. 24X (CD-ROM)/2X (DVD-RAM Ver.1.0)/1X (DVD-RAM Ver.2.1) Max. 10,820 KByte/s (DVD-ROM)/Max. 3,600KByte/s (CD-ROM) Sustained Transfer Rate

Buffer capacity

Matsushita SR-8177:	256 Kbytes (Max)
Toshiba SD-C2612	192 Kbytes (Max)

Supported formats

CD:	CD-Audio	CD-ROM (mode 1 and mode 2)	CD-ROM XA (mode 2, form 1 and form 2)
	CD-I Bridge	CD-I (mode 2, form 1 and form 2)	CD-TEXT
	Video CD	CD-RW	Photo CD
	CD-WO**	Enhanced Music CD (CD Plus)**	CD-I Ready**
	CD+(E)G*	CD-MIDI*	CD-R*
DVD	: DVD-5	DVD-9	DVD-10
	DVD-18*	DVD-RAM (2.6G/4.7G)	DVD-R (3.95G/4.7G)
	DVD-RW		
		SD-C2612 only	

** Matsushita SR-8177only

CD-RW/DVD-ROM Drive

The CD-RW/DVD-ROM combo drive (Toshiba SD-R2412 or TEAC DW-224E-85) is capable of driving either 12cm (4.72-inch) or 8cm (3.15-inch) DVDs and CDs without using an adaptor.

Read speeds DVD-ROM DVD-RAM CD-ROM		Standa	Maximum 8 times faster rotational speed Standard rotational speed Maximum 24 times faster rotational speed		
Write speeds CD-R CD-RW High-Spee	d CD-I	4 time	4,8,16,24 times faster rotational speed 4 times faster rotational speed 4,10 times faster rotational speed		
Access Speed Average Randon	n Acces	ss Time	DVD: CD: DVD-RAM:	100 ms typ (Toshiba S 110 ms typ (TEAC DV 90 ms typ (10.3-24X) 170 ms*	· · · · · · · · · · · · · · · · · · ·
Average Random Seek Time		DVD: CD: DVD-RAM:	85 ms typ* 80 ms typ (10.3-24X)* 130 ms typ*		
Average Full Stroke Access Time		DVD: CD: DVD-RAM:	170 ms typ* 160 ms typ (10.3-24X) 300 ms*	* * Toshiba SD-R2412	
Buffer capacity			2 Mbytes (Ma	ax)	
Supported forma Applicable Write Formats: Applicable Write Disc: Applicable Read Disc:	ats CD CD CD DVD	MI Mu CD-DA, CD- MODE CD, C CD, CD-EXT	 RW RW [CD-DA, CD+(E)G, CD-MIDI, CD-TEXT, CD-ROM, CD-ROM XA, MIXED MODE CD, CD-I, CD-I Bridge (Photo-CD, Video-CD), Multisession CD (Photo-CD, CD-EXTRA, Portfolio)] DA, CD+(E)G, CD-MIDI, CD-TEXT, CD-ROM, CD-ROM XA, MIXED DE CD, CD-I, CD-I Bridge (Photo-CD, Video-CD), Multisession CD (Photo- CD-EXTRA, Portfolio, CD-R, CD-RW), CD-R, CD-RW P-ROM [DVD-5, DVD-9, DVD-10, DVD-18] P-R P-RW 		D, Video-CD), lio)] COM XA, MIXED litisession CD (Photo-

1.4.3 DVD+-R/DVD+-RW Drive

The CD-RW/DVD-ROM combo drive (Toshiba SD-R2412 or TEAC DW-224E-85) is capable of driving either 12cm (4.72-inch) or 8cm (3.15-inch) DVDs and CDs without using an adaptor.

Read speeds DVD-ROM DVD-RAM CD-ROM		Stand	Maximum 8 times faster rotational speed Standard rotational speed Maximum 24 times faster rotational speed		
Write speeds CD-R CD-RW High-Spee	d CD-I	4 time	4,8,16,24 times faster rotational speed4 times faster rotational speed4,10 times faster rotational speed		
Access Speed Average Random	n Acces	ss Time	DVD: CD: DVD-RAM:	100 ms typ (Toshiba S 110 ms typ (TEAC DW 90 ms typ (10.3-24X) 170 ms*	/
Average Random	n Seek '	Time	DVD: CD: DVD-RAM:	85 ms typ* 80 ms typ (10.3-24X)* 130 ms typ*	
Average Full Stre	verage Full Stroke Access Time DVD: 170 ms typ* CD: 160 ms typ (10.3-24X)* DVD-RAM: 300 ms* * Toshiba SD-R24				* * Toshiba SD-R2412
Buffer capacity			2 Mbytes (Ma	ax)	
Supported forma Applicable Write Formats: Applicable Write Disc: Applicable Read Disc:	ats CD CD CD DVD	MI Mu CD-DA, CD MODE CD, CD, CD-EX	 RW R RW [CD-DA, CD+(E)G, CD-MIDI, CD-TEXT, CD-ROM, CD-ROM XA, MIXED MODE CD, CD-I, CD-I Bridge (Photo-CD, Video-CD), Multisession CD (Photo-CD, CD-EXTRA, Portfolio)] DA, CD+(E)G, CD-MIDI, CD-TEXT, CD-ROM, CD-ROM XA, MIXED DE CD, CD-I, CD-I Bridge (Photo-CD, Video-CD), Multisession CD (Photo- CD-EXTRA, Portfolio, CD-R, CD-RW), CD-R, CD-RW D-ROM [DVD-5, DVD-9, DVD-10, DVD-18] D-R D-RW 		

1.4.4 DVD Super Multi Drive

The CD-RW/DVD-ROM combo drive (Toshiba SD-R2412 or TEAC DW-224E-85) is capable of driving either 12cm (4.72-inch) or 8cm (3.15-inch) DVDs and CDs without using an adaptor.

Read speeds DVD-ROM DVD-RAM CD-ROM		Standa	Maximum 8 times faster rotational speed Standard rotational speed Maximum 24 times faster rotational speed		
Write speeds CD-R CD-RW High-Spee	ed CD-I	4 time	4,8,16,24 times faster rotational speed 4 times faster rotational speed 4,10 times faster rotational speed		
Access Speed Average Randon	Access SpeedAverage Random Access TimeDVD:100 ms typ (Toshiba SD-R2412) 110 ms typ (TEAC DW-224E-85)CD:90 ms typ (10.3-24X) DVD-RAM:170 ms*				
Average Randon	n Seek	Time	DVD: CD: DVD-RAM:	85 ms typ* 80 ms typ (10.3-24X)* 130 ms typ*	
Average Full Str	ull Stroke Access Time DVD: 170 ms typ* CD: 160 ms typ (10.3-24X)* DVD-RAM: 300 ms* * Toshiba SD-R241			* * Toshiba SD-R2412	
Buffer capacity			2 Mbytes (Ma	ax)	
Supported forma Applicable Write Formats: Applicable Write Disc: Applicable Read Disc:	ats CD CD CD DVD	MI Mu CD-DA, CD- MODE CD, CD, CD, CD-EXT	 -RW -R -RW [CD-DA, CD+(E)G, CD-MIDI, CD-TEXT, CD-ROM, CD-ROM XA, MIXED MODE CD, CD-I, CD-I Bridge (Photo-CD, Video-CD), Multisession CD (Photo-CD, CD-EXTRA, Portfolio)] -DA, CD+(E)G, CD-MIDI, CD-TEXT, CD-ROM, CD-ROM XA, MIXED -DE CD, CD-I, CD-I Bridge (Photo-CD, Video-CD), Multisession CD (Photo- , CD-EXTRA, Portfolio, CD-R, CD-RW), CD-R, CD-RW D-ROM [DVD-5, DVD-9, DVD-10, DVD-18] D-R D-RW 		D, Video-CD), lio)] COM XA, MIXED litisession CD (Photo-

1.5 Power Supply

The power supply supplies seven different voltages to the system board and performs the following functions:

1. A/D conversion

The EC uses 10-bit sampling for A/D conversion to determine the following values:

- AC adaptor current
- Battery and temperature
- 2. AC adaptor and battery check

The EC checks the following by A/D converted values:

• Battery installed

The EC checks the following by GPIO values:

- AC adaptor connected
- 3. Abnormal check

The EC determines whether the condition is abnormal, and if so, stores an error code into the error register.

4. Input port management

The EC monitors the following input signal status:

- System power ON/OFF status
- Direct CD power ON/OFF status
- 5. Beep and LED control

Beep is caused by the low battery status.

The EC controls the following two kinds of LED

DC IN LED (one color: green)

• Green = indicates AC adaptor is connected

Battery LED (two colors: orange and green)

• Green solid = The battery is fully charged.

- Orange = The computer is quick-charging the battery / The battery is low.
- 6. Power ON/OFF sequence

When power is turned on or off, the EC starts the power on or off sequence.

- SQ0-4 = power ON sequence
- SQ5-B = power OFF sequence
- 7. Battery charging control

The EC controls the following.

- The quick charging ON/OFF
- The detection of full charge
- 8. Detection of the low battery

The EC detects the low battery point by the gas gauge.

- LB10M= The system will be driven by the battery for 12 more minutes.
- LB0 = The battery won't be able to drive the system after 3 minutes.
- LB1 = The battery can drive the system only during the suspend process.
- LB2 = The battery cannot drive the system.
- 9. New battery installation

When a new battery is installed, the EC communicates with the E^2 PROM in the battery to read information of the newly installed battery.

10. Battery capacity calculation

The EC reads battery remaining and percentage capacity from the battery through SMBus.

1.6 Batteries

The computer has two types of battery:

□ Main battery pack (18650 size)

□ RTC battery

The removable main battery pack is the computer's main power source when the AC adaptor is not attached.

The battery specifications are listed in the table below.

Battery name	Material	Output voltage	Capacity
Main battery	Lithium-Ion	14.8 V	6450mAH/
			4300mAH
RTC battery	Lithium	3.3 V	15 mAh

1.6.1 Main Battery

Battery charging is controlled by a power supply microprocessor that is mounted on the system board. The power supply microprocessor controls whether the charge is on or off and detects a full charge when the AC adaptor and battery are attached to the computer. The system charges the battery using quick charge or trickle charge.

Quick Battery Charge

When the AC adaptor is attached, there are two types of quick charge: quick charge when the system is powered off and normal charge when the system is powered on.

The times required for charges are listed in the table below.

Status	Charging time
Normal charge (power on)	12 hours or longer
Quick charge (power off)	About 4 hours

NOTES

- 1. The time required for normal charge is affected by the amount of power the system is consuming. Use of the fluorescent lamp and frequent disk access diverts power and lengthens the charge time.
- 2. Using quick charge, the power supply microprocessor automatically stops the charge after eight hours regardless of the condition of the battery. Overcharging could cause the battery to explode.

If any of the following occurs, the battery quick charge process stops.

- 1. The battery becomes fully charged.
- 2. The AC adaptor or battery is removed.
- 3. The battery or output voltage is abnormal.
- 4. The battery temperature is abnormal.
- 5. The battery SMBus communication fails.
- 6. The battery cell is bad.
- Detection of full charge

A full charge is detected from the battery pack through SMBus when the battery is charging.

1.6.2 RTC battery

The RTC battery provides power to keep the current date, time and other setup information in memory while the computer is turned off. The table below lists the charging time and data preservation period of the RTC battery. The RTC battery is charged by the adaptor or main battery, while the computer is powered on.

Status	Time
Charging Time (power on)	About 48 hours
Data preservation period (full charge)	2 month

Chapter 2

Troubleshooting Procedures

Chapter 2 Contents

2.1	Troubleshooting Introduction	2-1
2.2	Troubleshooting Flowchart	
2.3	Power Supply Troubleshooting	
2.4	Display Troubleshooting	2-12
2.5	Keyboard Troubleshooting	<u>2-15</u>
2.6	External USB Devices Troubleshooting	
2.7	TV-Out Failure Troubleshooting	
2.8	Printer Port Troubleshooting	<u>2-21</u>
2.9	TouchPad Troubleshooting	<u>2-23</u>
2.10	Speaker Troubleshooting	
2.11	Optical Drive Troubleshooting	
2.12	Modem Troubleshooting	
2.13	PCMCIA Troubleshooting	
2.14	IEEE 1394 Troubleshooting	
2.16	Wireless LAN Troubleshooting	

Figures

Figure 2-1	Troubleshooting flowchart (1/2)	2-3
Figure 2-1	Troubleshooting flowchart (2/2)	2-4
Figure 2-2	Power Supply Troubleshooting Process	2-7
Figure 2-3	Display troubleshooting process	2-12
Figure 2-4	Keyboard troubleshooting process	<u>2-15</u>
Figure 2-5	External USB device troubleshooting process	<u>2-17</u>
Figure 2-6	TV-out troubleshooting process	
Figure 2-7	Printer port troubleshooting process	<u>2-21</u>
Figure 2-8	TouchPad troubleshooting process	
Figure 2-9	Speaker troubleshooting process	<u>2-25</u>
Figure 2-10	Optical drive troubleshooting process	2-27
Figure 2-11	Modem troubleshooting process	
Figure 2-12	PCMCIA troubleshooting process	2-32
Figure 2-13	IEEE 1394 troubleshooting process	2-34
Figure 2-14	Wireless LAN troubleshooting process	2-36

Tables

Table 2-1	Battery LED	
Table 2-2	DC-IN LED	2-9

2.1 Troubleshooting Introduction

Chapter 2 describes how to determine if a Field Replaceable Unit (FRU) in the computer is causing the computer to malfunction. The FRUs covered are:

1. Display	6. Printer (parallel) port	11.PCMCIA unit
2. USB Floppy Drive	7. TouchPad	12. IEEE 1394 port
3. Keyboard	8. Speaker	13. Wireless LAN system
4. USB ports	9. Optical drive	
5. TV-out port	10. Modem	

The Diagnostics Disk operations are described in Chapter 3. Detailed replacement procedures are given in Chapter 4.

The following tools are necessary for implementing the troubleshooting procedures:

- 1. Diagnostics Disk (Repair and Sound Repair)
- 2. Phillips screwdriver (2 mm)
- 3. 6mm nut driver (for the helix screw nuts on the rear ports for CPU door)
- 4. 2DD or 2HD formatted work disk for floppy disk drive testing
- 5. Printer port loopback connector
- 6. Sycard (PCMCIA test card)
- 7. Cleaning kit for floppy disk drive troubleshooting
- 8. Cleaning kit for optical drive troubleshooting
- 9. Multimeter
- 10. External monitor
- 11. USB compatible keyboard
- 12. Multimedia sound system with line-in and line-out ports
- 13. Headphones
- 14. USB test module and USB cable
- 15. Music CD

2.2 Troubleshooting Flowchart

If you know the location of the malfunction, turn directly to the appropriate section of this chapter. If the problem is unspecified, use the flowchart in Figure 2-1 as a guide for determining which troubleshooting procedures to execute. Before performing any troubleshooting procedures, verify the following:

- Ask the user if a password is registered and, if it is, ask him or her to enter the password.
- Verify with the customer that Toshiba Windows XP is installed on the hard disk. Operating systems that were not preinstalled by Toshiba can cause the computer to malfunction.
- Make sure all optional equipment is removed from the computer.
- Make sure the floppy disk drive, if installed, is empty. If no FDD module is installed, you should use an external FDD to run the diagnostics tests

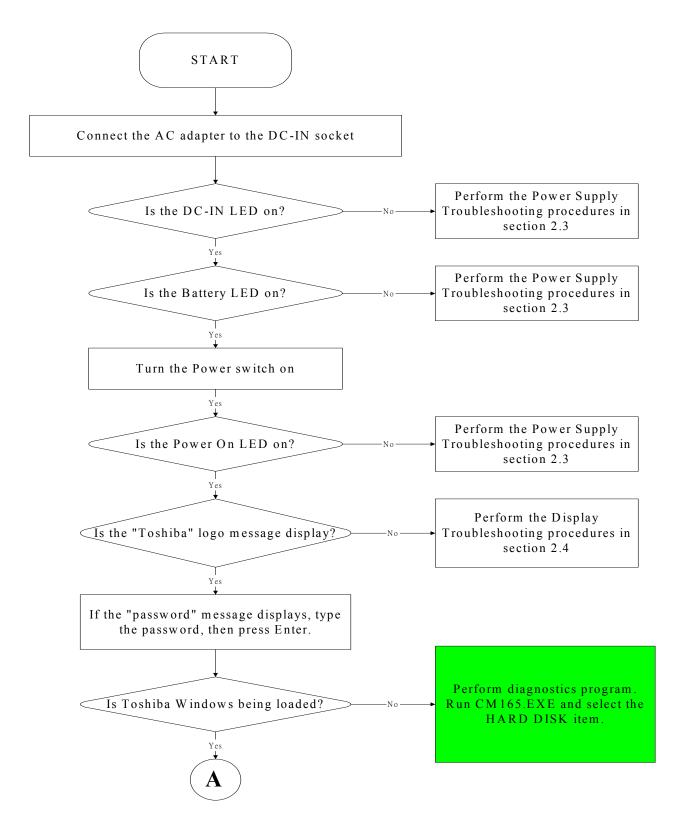


Figure 2-1 Troubleshooting flowchart (1/2)

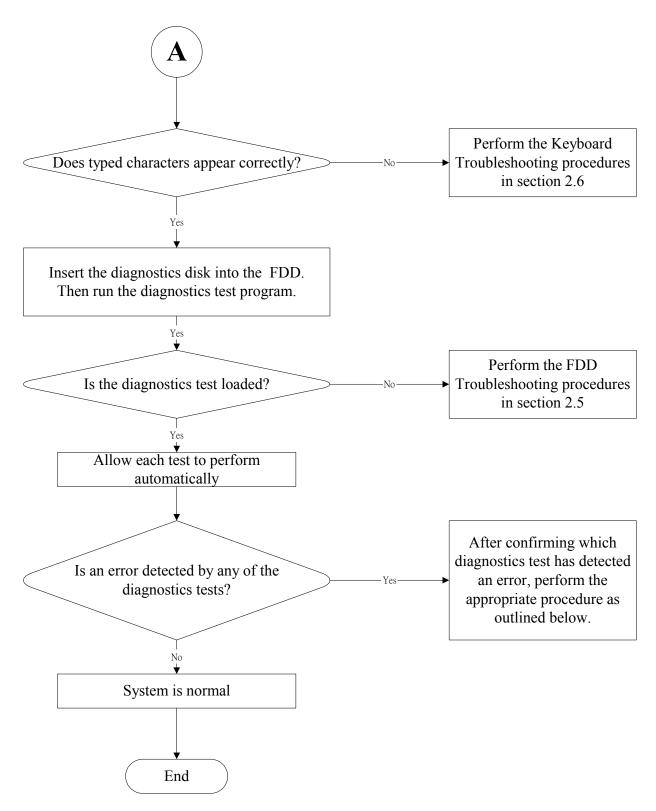


Figure 2-1 Troubleshooting flowchart (2/2)

If the diagnostics program cannot detect an error, the problem may be intermittent. The test program should be executed several times to isolate the problem. When a problem has been located, perform the appropriate troubleshooting procedures as follows:

- 1. If an error is detected by the battery test, perform the Power Supply Troubleshooting procedures in Section 2.3.
- 2. If an error is detected by the display test, perform the Display Troubleshooting procedures in Section 2.4.
- 3. If an error is detected by the keyboard test, perform the Keyboard Troubleshooting procedures in Section 2.5.
- 4. If an error is detected by the printer (parallel) port test, perform the Printer Port Troubleshooting procedures in Section 2.8.
- 5. If an error is detected by the TouchPad test, perform the TouchPad Troubleshooting procedures in Section 2.9.
- 6. If an error is detected by the audio test, perform the Speaker Troubleshooting procedures in Section 2.10 and the Optical Drive Troubleshooting Procedures in Section 2.12.
- 7. If an error is detected by the modem test, perform the Modem Troubleshooting Procedures in Section 2.12.

Other problems that are not covered by the diagnostics program may be discovered by a user.

- 1. If an error is detected when using an external USB device, perform the External USB Devices Troubleshooting procedures in Section 2.6.
- 2. If an error is detected when using the TV-out connection, perform the TV-Out Failure Troubleshooting procedures in Section 2.7.
- 3. If an error is detected when using the speakers, perform the Speaker Troubleshooting procedures in Section 2.10.
- 4. If an error is detected when using the modem, perform the Modem Troubleshooting procedures in Section 2.12.
- 5. If an error is detected when using the PCMCIA unit, perform the PCMCIA Troubleshooting procedures in Section 2.13.
- 6. If an error is detected when using the IEEE1394 device, perform the IEEE1394 device Troubleshooting procedures in Section 2.14.
- 7. If an error is detected when using the Wireless LAN, perform the Wireless LAN Troubleshooting procedures in Section 2.15.

2.3 Power Supply Troubleshooting

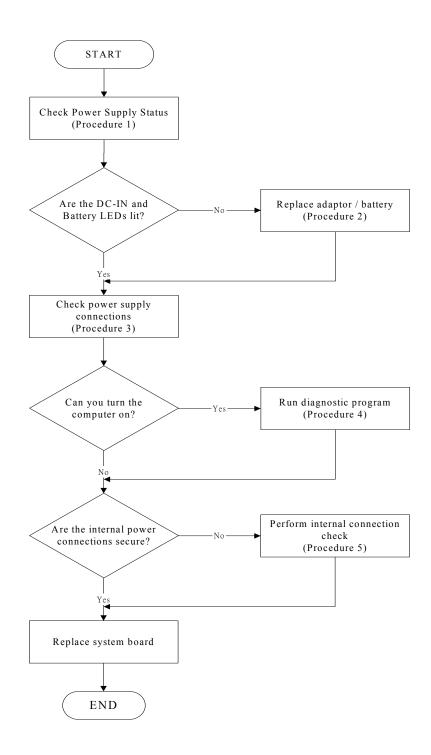


Figure 2-2 Power Supply Troubleshooting Process

The power supply controls many functions and components. To determine if the power supply is functioning properly, start with Procedure 1 and continue with the other Procedures as instructed. The flowchart in Figure 2-2 gives a summary of the process. The procedures described in this section are:

- Procedure 1: Power status check Procedure 2: Adaptor / battery replacement Procedure 3: Power supply connection check
- Procedure 4: Diagnostic check
- Procedure 5: Internal connection check

Procedure 1 **Power Status Check**

The following LEDs indicate the power supply status:



Battery LED



DC-IN LED

The power supply controller displays the power supply status through the Battery and the DC-IN LEDs as listed in the tables below.

Battery State	LED colors	Definition
Charging	Amber, solid on	Battery charging with AC.
	Green, solid on	Battery fully charged by AC
	Green color off	Battery abnormal stop charging with AC (Bad cell/ Overheated)
Discharging	Amber, blinking (LED on for 1 second every 4 seconds)	Battery within low state: 12 minutes remaining
	Amber, blinking (LED on for 1 second every 2 seconds)	Battery within critical low state: 3 minutes remaining. The system is protected and cannot be re-powered on without the AC power connected.
	Amber color off	Battery not in low or critical low state; It's in discharging state

Table 2-1 Battery LED

AC-IN LED	Power supply status
Solid on	AC power exists (LED is solid green).
Off	No AC power exists.

Table 2-2 DC-IN LED

To check the power supply status, install a battery pack and connect an AC adaptor to the DC-IN port on the computer and to a power supply.

If the DC-IN LED or Battery LED is not lit, go to Procedure 2.

Procedure 2 Adaptor / battery replacement

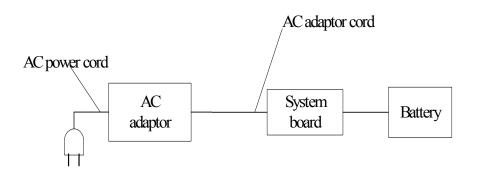
A faulty adaptor may not supply power or may not charge the battery. Perform Check 1.

Check 1 Connect a new AC adaptor. If the problem is not resolved, go to Check 2.

Check 2 Insert a new battery. If the problem is still not resolved, go to Procedure 3.

Procedure 3 Power supply connection check

The power supply wiring diagram is shown below:



Any of the connectors may be disconnected. Perform Check 1.

- Check 1 Disconnect the AC power cord from wall outlet. Check the power cable for breaks. If the power cord is damaged, connect a new AC power cord. If there is no damage, go to Check 2.
- Check 2 Make sure the AC adaptor cord and AC power cord are firmly plugged into the DC-IN socket, AC adaptor inlet and wall outlet. If these cables are connected correctly, go to Check 3.
- Check 3 Make sure that the DC-IN input port socket is firmly secured to the system board of the computer.
 - If the DC-IN input socket is loose, go to Procedure 5.
 - If it is not loose, go to Check 4.
- Check 4 Use a multi-meter to make sure that the AC adaptor output voltage is close to 19 V. If the output is several percent lower than 19 V, go to Check 5. If the output is close to 19 V, go to Check 6.
- Check 5 Connect a new AC adaptor or AC power cord.
 - If the DC-IN LED does not light, go to Procedure 4.
 - If the battery LED does not light, go to Check 6.
- Check 6 Make sure the battery pack is installed in the computer correctly. If the battery is properly installed and the battery LED still does not light, go to Procedure 4.

Procedure 4 Diagnostic check

The power supply may not charge the battery pack. Perform the following procedures:

- 1. Reinstall the battery pack.
- 2. Attach the AC adaptor and turn on the power. If you cannot turn on the power, go to Procedure 5.
- 3. Run the Diagnostic test following the procedures described in Chapter 3, Tests and Diagnostics. If no problem is detected, the battery is functioning normally.

Procedure 5 Replacement check

The system board may be disconnected or damaged. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures*. Check the connection between the AC adaptor and the system board. After checking the connection, perform Check 1:

- Check 1 Use a multi-meter to make sure that the fuses on the system board are not blown. If a fuse is not blown, go to Check 2. If a fuse is blown, go to Check 3.
- Check 2 Make sure that the battery cable is firmly connected to the system board. If it is connected firmly, go to Check 3.
- Check 3 The system board may be damaged. Replace it with a new one following the instructions in Chapter 4.

2.4 Display Troubleshooting

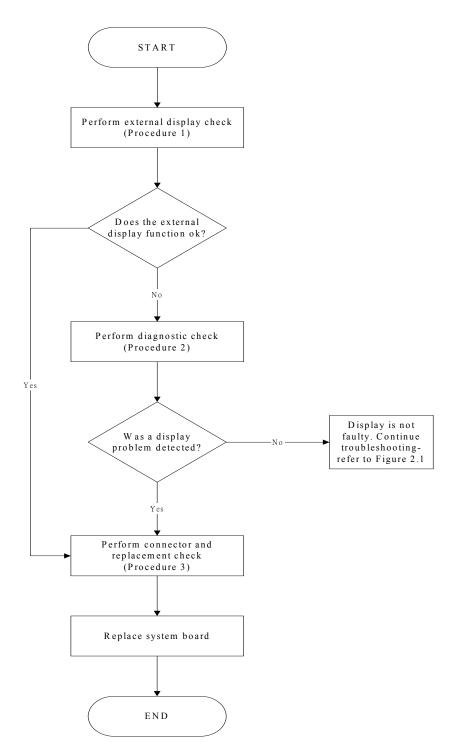


Figure 2-3 Display troubleshooting process

This section describes how to determine if the computer's display is functioning properly. The process is outlined in Figure 2-3. Start with Procedure 1 and continue with the other procedures as instructed.

Procedure 1: External display checkProcedure 2: Diagnostic checkProcedure 3: Connector and replacement check

Procedure 1 External display check

Connect an external display to the computer's external monitor port, then boot the computer. The computer automatically detects the external display.

If the external display works correctly, the internal LCD may be damaged. Go to Procedure 3.

If the external monitor appears to have the same problem as the internal monitor, the system board may be damaged. Go to Procedure 2.

Procedure 2 Diagnostic check

The Display Test program is stored on the computer's Diagnostics disk. This program checks the display controller on the system board. Insert the Diagnostics disk in the computer's floppy disk drive, turn on the computer and run the test. Refer to Chapter 3, *Tests and Diagnostics* for details.

If an error is detected, go to Procedure 3. If an error is not detected, the display is functioning properly.

Procedure 3 Connector and replacement check

The FL inverter board, LCD module, and system board are connected to the display circuits. Any of these components may be damaged. Refer to Chapter 4, *Replacement Procedures*, for instructions on how to disassemble the computer and then perform the following checks:

- Check 1 Make sure the DDR RAM module is seated properly. Test display again. If the problem still exits, replace the DDR RAM module. If the problem still exists, perform Check 2.
- Check 2 Replace the FL inverter board with a new one and test display again. If the problem still exists, perform Check 3.
- Check 3 Replace the LCD module with a new one and test display again. If the problem still exists, perform Check 4.
- Check 4 Replace the LCD/FL cable with a new one and test display again. If the problem still exists, perform Check 5.
- Check 5 Replace the CPU with another of the same specifications. If the problem still exists, perform Check 6.
- Check 6 The system board may be damaged. Replace it with a new one.

2.5 Keyboard Troubleshooting

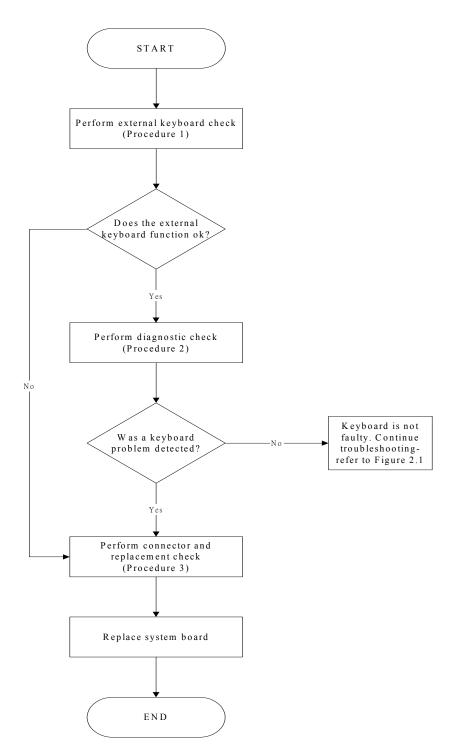


Figure 2-4 Keyboard troubleshooting process

To determine if the computer's keyboard is functioning properly, perform the following procedures. Figure 2-5 outlines the process. Start with Procedure 1 and continue with the other procedures as instructed.

Procedure 1: External keyboard checkProcedure 2: Diagnostic checkProcedure 3: Connector and replacement check

Procedure 1 External keyboard check

Connect a USB keyboard to one of the computer's USB ports, then boot the computer. The computer automatically detects the external keyboard.

If the external keyboard works correctly, the internal keyboard or its connections may be faulty. Go to Procedure 2.

If the external keyboard appears to have the same problem as the internal keyboard, the system board may be damaged. Replace it with a new one following the instructions in Chapter 4.

Procedure 2 Diagnostic check

Run the Diagnostic Program, which will automatically execute the Keyboard Test. Refer to Chapter 3, *Tests and Diagnostics* for more information on how to run the program.

If an error is located, go to Procedure 3. If an error does not occur, the keyboard is functioning properly.

Procedure 3 Connector and replacement check

The keyboard and/or system board may be disconnected or damaged. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures* and perform the following checks.

Check 1 Make sure the keyboard cable is firmly connected to the system board.

If the connection is loose, reconnect firmly and repeat Procedure 2. If there is still an error, go to Check 2.

Check 2 The keyboard may be damaged. Replace it with a new one following the instructions in Chapter 4.

If the problem still exists, perform Check 3.

Check 3 The system board may be damaged. Replace it with a new one following the instructions in Chapter 4.

2.6 External USB Devices Troubleshooting

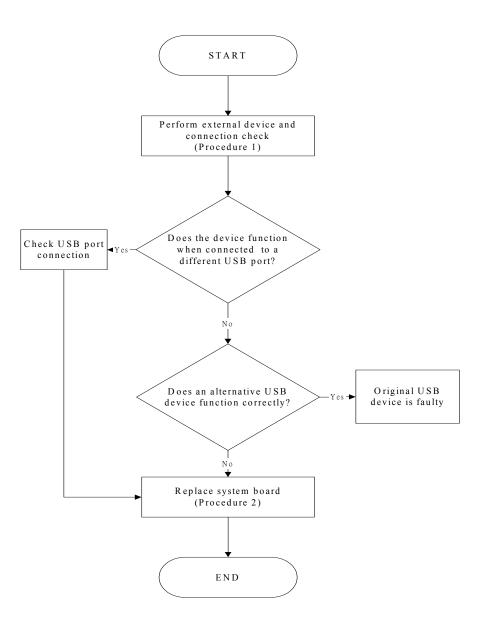


Figure 2-5 External USB device troubleshooting process

To determine if the computer's external USB devices are functioning properly, perform the following procedures. Figure 2-6 outlines the process. Start with Procedure 1 and continue as instructed.

Procedure 1: External device and connection check

Procedure 2: Replace system board

Procedure 1 External device and connection check

The USB device may be damaged or the connection may be faulty. Perform Check 1.

- Check 1 Make sure USB device cable is firmly plugged into one of the USB sockets. If the cable is connected correctly, go to Check 2.
- Check 2 Plug the USB device into another USB socket (there are three in all). If the USB device still does not work, go to Check 4.

If the device functions correctly when connected to another USB port, go to Check 3.

- Check 3 Make sure that the USB socket is firmly secured to the system board of the computer. If the malfunction remains, the system board may be damaged. Go to Procedure 2.
- Check 4 Connect an alternative USB device to one of the computer's USB ports, and then boot the computer. The computer automatically detects the external device.

If the alternative USB device works correctly, the original device may be damaged and should be replaced.

If the alternative USB device appears to have the same problem as the original device, the system board may be damaged. Go to Procedure 2.

Procedure 2 Replace system board

If the error persists, the system board may be damaged. Replace it with a new one following the instructions in Chapter 4.

2.7 TV-Out Failure Troubleshooting

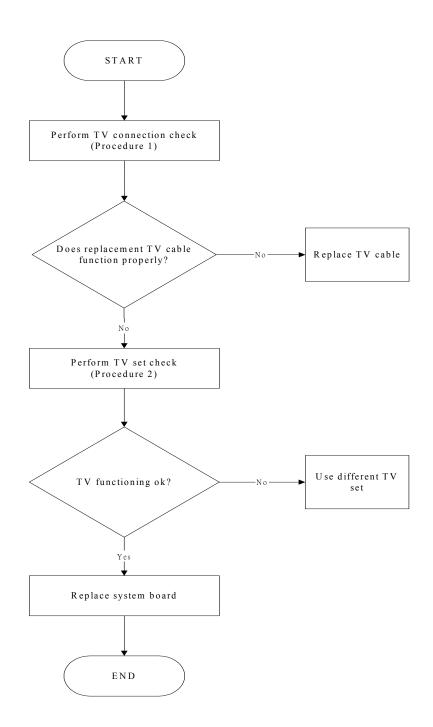


Figure 2-6 TV-out troubleshooting process

To determine if the computer's TV-out port is functioning properly, perform the following procedures. Figure 2-7 outlines the process. Start with Procedure 1 and continue as instructed.

Procedure 1:TV connection checkProcedure 2:TV set check

Procedure 1 TV connection check

The TV cable may be damaged or the connections may be loose. Perform Check 1:

- Check 1 Make sure TV cable is firmly plugged into both the TV set and the TV-out port of the computer. If the cable is connected correctly, go to Check 2.
- Check 2 Make sure the TV-out port is firmly secured to the system board of the computer. If the malfunction remains, go to Check 3.
- Check 3 The TV cable may be damaged. Replace with a good cable. If the malfunction remains, go to Procedure 2.

Procedure 2 TV set check

The TV set may be faulty. Perform Check 1:

- Check 1 Try using the set for television reception. If it does not work, the set may be damaged. If the set does work, perform Check 2.
- Check 2 Try connecting a different television to the computer. If the replacement television works, the original set may be damaged. If the replacement set does not work the system board may be damaged. Replace it with a new one following the instructions in Chapter 4.

2.8 Printer Port Troubleshooting

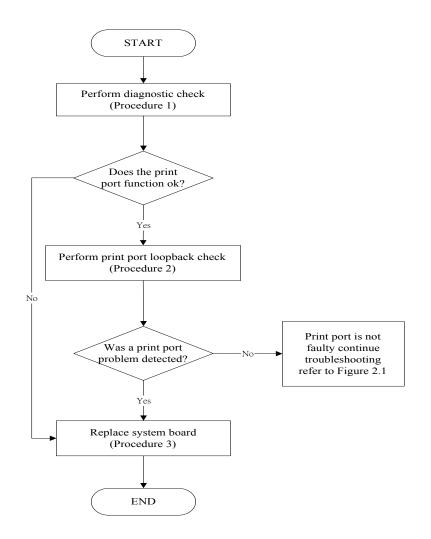


Figure 2-7 Printer port troubleshooting process

To determine if the computer's printer (parallel) port is functioning properly, perform the following procedures. Figure 2-8 outlines the process. Start with Procedure 1 and continue as instructed.

Procedure 1: Diagnostic checkProcedure 2: Printer port loopback checkProcedure 3: Replace system board

Procedure 1 Diagnostic check

Attach the printer port loopback connector firmly to the printer port and run the Diagnostic Program. See Chapter 3 for details. If the printer port test passes, there may be a problem with the printer. Go to Procedure 2. If the printer port test fails, go to Procedure 3.

Procedure 2 Printer port loopback check

The printer may be faulty or not connected properly. Perform Check 1.

- Check 1 Make sure printer cable is firmly plugged into both the printer and the printer port of the computer. If the cable is connected correctly, go to Check 2.
- Check 2 Make sure the printer port is firmly secured to the system board of the computer. If the malfunction remains, go to Check 3.
- Check 3 The printer cable may be damaged. Replace with a good cable. If the malfunction remains, go to Check 4.
- Check 4 The printer may be faulty. Replace it with a good printer or connect it to a different computer.

If the replacement printer works or the original printer does not work on a different computer, the printer should be replaced.

If the replacement printer does not work either, or the original printer functions normally on a different computer, go to Procedure 3.

Procedure 3 Replace system board

The system board may be damaged. Replace it with a new one following the instructions in Chapter 4.

2.9 TouchPad Troubleshooting

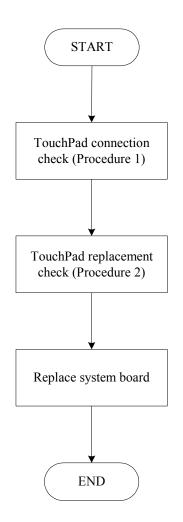


Figure 2-8 TouchPad troubleshooting process

To determine if the computer's built-in TouchPad is functioning properly, perform the following procedures. Figure 2-9 outlines the process. Start with Procedure 1 and continue as instructed.

Procedure 1: TouchPad connection check

Procedure 2: TouchPad replacement check

Procedure 1 TouchPad connection check

The TouchPad is connected via the TouchPad FPC to the system board. Make sure the TouchPad FPC cable is firmly connected to the TouchPad and system board. Refer to Chapter 4, *Replacement Procedures,* for instructions on how to disassemble the computer and then perform the following checks.

If any of the connections are loose, reconnect firmly. If any of the connections is damaged, or there is still an error, go to Procedure 2.

Procedure 2 TouchPad replacement check

The TouchPad unit or FPC may be defective or damaged. Replace each with a new one following the steps in Chapter 4. If the FDD is still not functioning properly, replace the system board with a new one following the steps in Chapter 4.

2.10 Speaker Troubleshooting

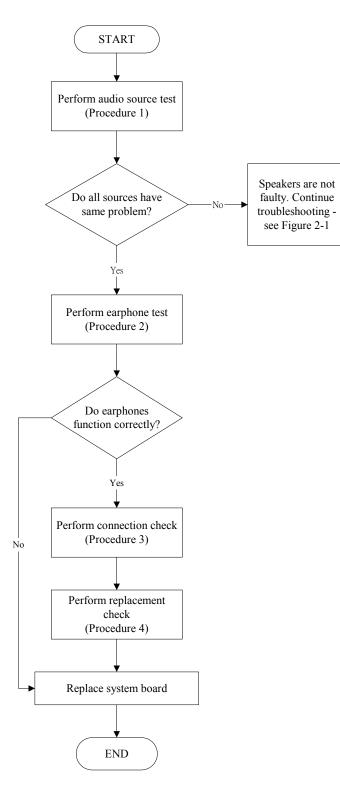


Figure 2-9 Speaker troubleshooting process

To determine if the computer's built-in speakers are functioning properly, perform the following procedures. Figure 2-10 outlines the process. First adjust the speaker volume to an appropriate level. Start with Procedure 1 and continue as instructed.

Procedure 1: Audio source testProcedure 2: Earphone testProcedure 3: Connection checkProcedure 4: Replacement check

Procedure 1 Audio source test

Try different audio sources (e.g. an audio CD and digital music file) to determine whether the fault is in the speaker system or not. If not all sources have sound problem, the problem is in the source devices. If all have the same problem, continue with Procedure 2.

Procedure 2 Earphone test

Connect a set if earphones or external speakers. If these function correctly, go to Procedure 3. If they do not function correctly, the system board may be defective or damaged. Replace it with a new one.

Procedure 3 Connection check

Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures* and make sure the speaker cable is firmly connected to the audio board. If the stereo speakers are still not functioning properly, go to Procedure 4.

Procedure 4 Replacement check

If the stereo speakers don't sound properly, the stereo speakers may be defective or damaged. Replace them with new ones. If the stereo speakers still do not work properly, try replacing in turn the audio board and system board.

Chapter 3

Tests and Diagnostics

3. Tests and Diagnostics

Contents

3.1	The Diagnostic Test	
3.2	Executing the Diagnostic Test	
3.3	Config Check Test	
3.4	DMI Check Test	
3.5	PIO Loopback Test	
3.6	IEEE 1394 Test	
3.7	Speaker Audio Test	
3.8	Fan ON/OFF Test	
3.9	Main Battery Charge Test	
3.10	FDD Test	
3.11	CD-ROM Test	
3.12	Keyboard Test	
3.13	Mouse (Pad) Test	
3.14	LCD Pixels Mode Test	
3.15	Lid Switch Test	
3.16	HDD R/W Test	
3.17	LAN Test	
3.18	RTC Test	
3.19	CD Control Button Test	

3. Tests and Diagnostics

3.1 The Diagnostic Test

This chapter explains how to use the Test & Diagnostic program to test the functions of the computer's hardware modules. The Test & Diagnostic Program is stored on the T&D diskettes. The program consists of a series of tests that run automatically when the Diagnostics Program items are selected and executed.

NOTES: To start the diagnostics, follow these steps

1. Check all cables for loose connections.

2. Exit this program when you are at Main Menu.

The TEST & DIAGNOSTIC PROGRAM contains the following functional tests:

- □ CONFIG CHECK TEST
- DMI CHECK TEST
- □ PIO LOOPBACK TEST
- □ IEEE1394 TEST
- □ SPEAKER AUDIO TEST
- □ FAN ON/OFF TEST
- □ MAIN BATTERY CHARGE TEST
- □ FDD TEST
- CD-ROM TEST
- KEYBOARD TEST
- □ MOUSE(PAD) TEST
- □ LCD PIXELS MODE TEST
- □ LID SWITCH TEST
- □ HDD R/W TEST
- LAN TEST
- RTC TEST

You will need the following equipment to perform some of the Diagnostic test programs.

- □ The diagnostics diskette (2 pcs)
- □ A printer loopback connector (PIO Loopback Test)
- A formatted working diskette for the floppy disk drive test (Floppy Disk Drive Test)
- □ A data CD disc (CD-ROM Test)
- □ A LAN loopback connector (LAN Test)
- □ IEEE1394 Link Cable

The following sections explain how to execute the Test & Diagnostic Program and detail the tests within the program.

3.2 Executing the Diagnostic Test

Toshiba MS-DOS is required to run the DIAGNOSTICS PROGRAM. To start the DIAGNOSTIC PROGRAM, follow these steps:

1. Insert the diagnostics diskette #1 in the floppy disk drive and turn on the computer. (The diagnostics diskette contains the MS-DOS boot files.) And then follow the instructions to swap with the diagnostics diskette #2 for T&D program installed in RAM driver.

NOTE: To execute the CD test, make sure the CD is installed in the CD/DVD-ROM drive.

The T&D Program can run by single test item when you press corresponsive English letter of test item, or run two or more test items what you like if you choose them by "Arrow cursors" and "Space Bar" – the wonderful thing is you can setup test loop by "Enter" button. And it also asks you if you like to copy test log file to diskette as reference at the end of test(s).

The test list is as the following:

- A. CONFIG CHECK TEST
- B. DMI CHECK TEST
- C. PIO LOOPBACK TEST
- D. RTC TEST
- E. LAN TEST
- F. SPEAKER AUDIO TEST
- G. FAN ON/OFF TEST
- H. MAIN BATTERY CHARGE TEST
- I. FDD TEST
- J. CD-ROM TEST
- K. KEYBOARD TEST
- L. MOUSE (PAD) TEST
- M. LCD PIXELS MODE TEST
- N. LID SWITCH TEST
- O. HDD R/W TEST
- P. D1 STEPPING TEST

The below display will show up at the beginning of T&D program

J.CD-ROM TEST	<pre>< NO > T.N/A < NO > U.N/A < NO > U.N/A < NO > U.N/A < NO > W.N/A < NO > W.N/A < NO > X.COPY LOG TO FDD</pre>	NO NO NO NO NO NO NO NO
	Space=Change Option	Cursor

If the test result passes, the following display will show up:

Press any key to cont	inue		

If an error is detected and a test fails, the following message displays:



Then press any key for next actions – the below display presented if copying test log file onto diskette is necessary. This action will be executed when "Y" key pressed.

A.CONFIG CHECK TEST B.DMI CHECK TEST C.PIO LOOPBACK TEST D.RTC TEST E.LAN TEST F.SPEAKER AUDIO TEST G.FAN ON/OFF TEST H.MAIN BATTERY CHARGE TEST I.FDD TEST J.CD-ROM TEST K.KEYBOARD TEST L.MOUSE (PAD) TEST	Image: Constraint of the second state of the sec	22222222222222222222222222222222222222
	*Space=Change Option	e Cursor
MESSAGE:	LOOP:	

It will skip this process if "N" key pressed.

And then it will check if it's necessary to leave this program. Program will quit when "**Y**" key pressed and it will go back main menu for next test if "**N**" key pressed.

A.CONFIG CHECK TEST B.DMI CHECK TEST C.PIO LOOPBACK TEST D.RTC TEST E.LAN TEST F.SPEAKER AUDIO TEST G.FAN ON/OFF TEST H.MAIN BATTERY CHARGE TEST I.FDD TEST J.CD-ROM TEST K.KEYBOARD TEST L.MOUSE (PAD) TEST	✓ NO M.LCD PIXELS MODE TEST ► NO N.LID SWITCH TEST ► NO O.HDD R/W TEST ► NO P.CPU D1 STEPPING TEST ► NO Q.N/A ► NO S.N/A ► NO T.N/A ► NO U.N/A ►< NO U.N/A	25555555555555555555555555555555555555					
*[A-X]=Unit Item Test *Enter=Set Loop Count	*Space=Change Option *↑↓→←=Move *Press Esc To Quit	Cursor					
MESSAGE: Do you copy log to floppy ? (y/n) LOOP:							

NOTE: Press **Pause** to pause a test and **Enter** to resume.

3.3 Config Check Test

The config check test checks unit configuration. It includes:

- CPU type
- System memory size
- ODD type
- HDD type & capacity
- BIOS version

This test needs input unit Part Number by manual to make comparison with known SKU data.

NOTE: To execute this test, you must input unit Part Number as "Uppercase Character".

Then it will show its configuration is correct (in green color) or failed (in red color).

The screen should display as below, indicating whether the test is passed or failed after comparison.

(Neil Fu> <2002/6/18> <Ver 1.0> Command Line: cfgchk TabFileName SKU Example : cfgchk btw10tab.txt PS110E-0002S-GR Please input the SKU: PSP20UFZ000F CURRENT SPEC IS : P4800 2800 1.00A ID7 32MB 256 DVDR/RW HDD 60010 MODEM_LAN NoWEP NO_BT FIR 12cell Press any key to continue . . .

3.4 DMI Check Test

This test will check if the computer's Desktop Management Interface (DMI) is correct.

DMI includes:

- Manufacturer
- Production Name
- Version
- Serial Number
- UUID
- OEM String

It needs to input unit Part Number by manual, then show this unit DMI information and makes comparison with SKU data.

NOTE: To execute this test, you must input unit Part Number as "Uppercase Character".

The screen should display as below, indicating whether the test is passed or failed after comparison.



3.5 PIO Loopback Test

The PIO loopback test will check below items through PIO loopback connector.

- External Interrupt
- External Loopback
 - including Pattern test, Data Pin test, Control register test & Control pin/ Status pin test.

NOTE: Remember to connect a PIO loopback connector to the computer's printer port before test begins.

The screen should display as below, indicating whether the test is passed or failed when finished.

***** Parallel Port Test Program !! *** V1.0 10/16/00 **
Testing LPT1 Internal Loopback: Testing patterns...FF FF [PASS]
Testing LPT1 External Interrupt...[PASS]
Testing LPT1 External Loopback...
1. Data Pin (p2~p9) & Err Pin (p15) Test ...[PASS]
2. Control Register Test ...[PASS]
3. Control Pin & Status Pin Test ...[PASS] [PASS]
Press any key to continue . . .

3.6 IEEE 1394 Test

The IEEE 1394 port test checks transmission between the computer and a secondary device along an IEEE 1394 line. An IEEE 1394 transmission line must be firmly connected between the computer and the device before the test is started. The test requires:

- 1. An IEEE 1394-compatible device
- 2. An IEEE 1394 transmission line

To perform the test:

- 1. Copy the following files from the BTR20.RAR file on the diagnostics disk to a bootable diskette
 - 1394M.bat
 - TI.exe
 - TI1394.exe
- 2. Insert the disk, then boot the computer
- 3. Make sure the machines are firmly connected by the IEEE 1394 transmission line
- 4. Execute 1394M.bat on the computer
- 5. Select the IEEE 1394 transmission test for the test device
- 6. Start data transmission and complete check

🎇 MS-DOS 模式		
自動 💽 🛄 🖻 🔁 🖸		
TI-ECHO test progra Version 1.06 BETA (am for Texas Instruments OHCI Device (May 11 2001) Copyright (C) 2001	
Async Mode Test Status PX S100 PASS S200 PASS S400 PASS	Iso Mode Test Status PX S100 PASS S200 PASS S400 PASS	
Final Status PASS	ISO Channels Set. Enabling all ports Starting the test. Test complete Press'X' to exit	
A:\>		

3.7 Speaker Audio Test

The speaker audio test allows the user to aurally confirm the speaker functions. And check both speakers if they are OK within 3 times "Beep" sound generated.

NOTE: Remember to tune up the volume as "Maximum" before this test starts.

The screen should display as below, indicating whether the test is passed or failed after the question.

** FATBUZER test version 1.07 ** Please listen for speaker being sound 1.0 Sec by 3 times 3 times Test over, no errors found Do you hear Beep sound ? [Y,Ñ]?

3.8 Fan ON/OFF Test

The fan test allows the user to test aurally whether the fan is working. And follow the below procedures for this test:

• The computer will let the fan be "ON" after any key pressed. Listen to check whether the fan is working.

NOTE: Remember to approach fan outlet that is near right side of unit whether fan is "ON".

• The computer will stop the fan working after any key pressed. Listen to check if the fan is "OFF" – it means no rotating sound.

The screen should display as below, indicating whether the test is passed or failed after the question.

```
** Fan ON/OFF Test ,Please Listen To The FAN Sound !!
Press Any Key To Start Test ..
FAN On Test :
FAN Off Test :
Do you hear FAN rotating sound?
[Y,N]?
```

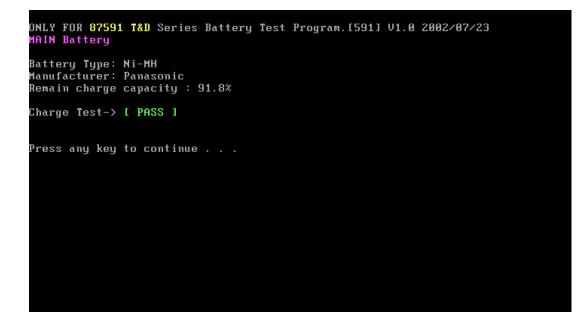
3.9 Main Battery Charge Test

NOTE: The AC adaptor (120W/90W, 19V) should be connected to successfully run this test.

This test shows and measures the main battery:

- Battery type (Ni-MH / Lion)
- Manufacturer (Sony / Sanyo)
- Remain charge capacity $(0 \sim 100\%)$
- Charge function (PASS/FAIL)
 - "Battery Is Full" showed when "remain charge capacity" is 100%

The screen should display as below, indicating whether the test is passed or failed when finished.



3.10 FDD Test

NOTE: Before running the FDD test, prepare a formatted work diskette (1.44 MB). Remove the diagnostics diskette and insert the work diskette into the FDD. The contents of the floppy diskette maybe erased.

The Floppy Disk Test includes three subtests of the:

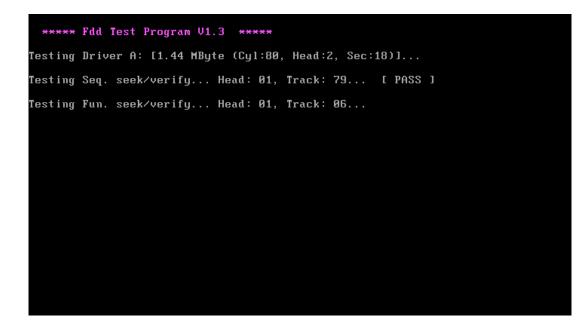
- 1. Sequential seek/verify function (Range: Track $0 \sim 79$)
- 2. Funnel code seek/verify function (Range: Track $0 \sim 79$)
- 3. Write/Read/Compare pattern function (Range: Track 75 ~ 79)

NOTE: The write-protected device of this formatted diskette should be "Disable".

The subtests run automatically.

NOTE: *Press "Esc" key can skip the current subtest.*

The screen should display as below, indicating whether the subtests pass or fail when finished.



3.11 CD-ROM Test

The CD-ROM test allows a user to aurally confirm the CD-ROM functions.

NOTE: A CD disc (including data file) must be inserted into the CD-ROM drive before this test starts.

The CD-ROM test includes two subtests of the:

- 1. Random read/partial sequential read function
- 2. Sequential read function (for all surface)

Each item can be chosen by manual. When each test item finished, the CD-ROM tray will open. Check whether the tray can open automatically.

NOTE: Press "Esc" key can skip the current subtest.

The screen should display as below, indicating whether the subtests pass or fail when finished.

CDROM Utility (for Testing only) Ver 1.0
Testing CDROM Information Press [ESC] key to skip testing
CD ROM Drive Z:, MSCDEX ver.: 2.23, Driver name: TSYCD1 , Vol.: 020329_1105 Total 198960 sectors(2352 bytes/sector) = 467953920 bytes Testing CD ROM reset function
Partial sequential read 198950
Random read
Please remove CD Media, then close CD tray
Press any key to continue

3.12 Keyboard Test

The keyboard test checks the all keys function.

NOTE: The Num Lock and the Overlay mode must be off to execute the keyboard test.

Before keyboard test starts, the keyboard matrix code should be chosen as below display:

- 1. **K** (UK, for Europe)
- 2. **S** (US, for America)
- 3. **J** (JP, for Japan)

When you execute this test, the keyboard layout is drawn on the display. When any key is pressed, the corresponding key on the screen changes to black as shown below.

It will indicate whether the subtest is passed or failed after the question.

NOTE: The "**Fn**" key cannot be tested in the keyboard test. To determine whether the "**Fn**" key is working correctly, press "**Fn**+**F6**" or "**Fn**+**F7**" keys to check if LCD display brightness change gradually.



<mark>Version: 1.60</mark> ▶Keyboard pad sequential test: BTS88 86 Key UK matrix∢ <mark>10</mark>												
ESC	F1 F	2 F3	F4	F5 I	6 F7	P F8	F9	F10 I	F11 F	12 PSC	PAU W	IN PRN
1	2	3	4	5	6	7	8	9	Θ	-	= BC	K HME
TAB	Q	W	Е	R	Т	Y	U	Ι	0	P	1	N PGU
CAL	A	S	D	F	G	н	J	K	L	1	* ENT	r PGD
LS	Ζ	×	С	V	В	Ν	М			1	RS	END
CTR	FN	ALT	${\bf x}_{i}$		SPO	;		< 1	INS	DEL A	LT	1
e 🖡 e												
			Pres			ınd ≺F Break		wn≻ ke <mark>it</mark>	ey.			



Pressing a key also reveals that key's **scan codes** in the upper right hand corner of the screen. When the key is depressed, its **make code** is displayed. When the key is released, the **break code** is shown.

3.13 Mouse (Pad) Test

The Mouse test allows the user to select and assign values to the following, using the Touch Pad or "*Tab*" key to move between selections:

- 1. Mouse Speed (on a scale from slow to fast)
- 2. Acceleration (Off, Low, Medium, High)
- 3. Button Assignments (Left + Right / Right button, either Unassigned or Drag Lock)
- 4. Swap Buttons (Left /Right)

NOTE: The Touch Pad test cannot be used to test an external USB mouse.

The Touch Pad button subtest allows users to test their Touch Pad buttons. If the buttons are clicked, the cursors should appear in the corresponding box of the button figure that is displayed on the screen as below.

Logitech Mouse Control Cente	r
Mouse Speed Fast	ОК
	Cance 1
Acceleration () Off () Medium (+) Low () High	
Button Assignments Left + Right — Right Button — (+) Unassigned () Drag Lock (-) Drag Lock	•
Swap Buttons [] Left/Right	
You may use the TAB key to go from one button to the next, and ENTER to select.	

After checking T/Pad buttons and cursor's function, use "Tab" key or use T/Pad cursor to click the "OK" column will end this test.

It will indicate whether the subtests pass or fail after three questions.

NOTE: The above figure has three compartments although the Touch Pad installed may only have two buttons. In this case, the central compartment in the figure does not correspond to any button.

3.14 LCD Pixels Mode Test

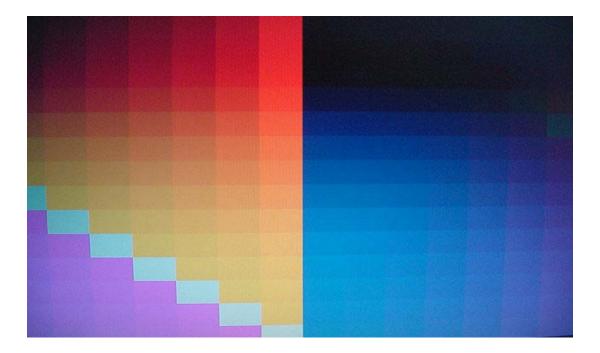
This LCD pixels mode test checks whether video display is fine.

This test includes two modes of the test:

- 1. Text Mode
 - including 40*25 (16 colors) and 80*25 (2/16colors).
- 2. VGA Mode

- including 320*200 (4/16/256 colors), 640*200 (2/16 colors), 640*350 (2/16 colors), 640*480 (2/16/256 colors), 800*600 (256 colors) and 1024*768 (256 colors).

The screen should display as below, indicating whether the test is passed or failed after the question.



3.15 Lid Switch Test

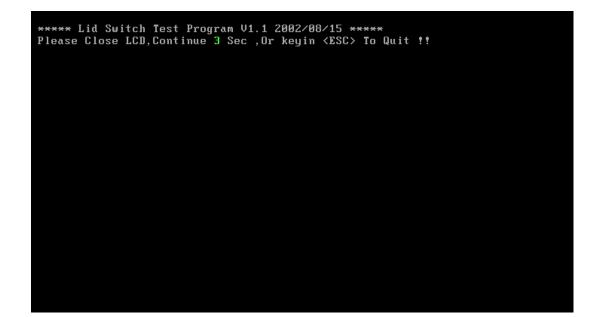
The lid switch test checks the lid function of the unit. When LCD cover closed, the lid should enable to turn off the display.

NOTE: Remember to tune up the volume as "Maximum" before this test starts.

Follow below steps to run this test:

- 1. Close the LCD cover.
- 2. Heard 3 "Beep" sound happened during LCD closed.
- 3. Open the LCD.

Then it will indicate whether the test is passed or failed.



3.16 HDD R/W Test

The HDD R/W test allows the user to test aurally HDD read/write function. For data security concern, it is necessary to input password - "**TOSHIBA**" before HDD write test starts.

The HDD test includes three subtests of the:

- 1. Sequential read (all surface)
- 2. Sequential write (all surface)
- 3. Partial W/R + Random W/R

After the choice is made, HDD information will show as below:

- Model name
- Firmware revision
- Serial number
- CHR (Cylinder High Register) mode including cylinders, heads, sectors and sizes.
- LBA (Logical Block Addressing) mode including sectors and sizes.
- Support Ultra DMA Mode
- Support PIO Mode

HDD Utili	ty (for Testing only) Ver 1.0
Testing HDD Information	Press Ctrl+Break keys to stop testing
Model name	= IC25N030ATCS04-0
Firmware revision	= CA30A71A
	= CSL304D5CARPWA
CHR Mode cylinders	
	= 16
CHR Mode sectors	
CHR Mode sizes	
LBA Mode sectors	
LBA Mode sizes	
Support Ultra DMA Mode	
Support PIO Mode	= 11
Bogin Tosting St	equential read (all surface)
> Testing of Sector	
/ lesting of Sector	12 - 17200241

NOTE: Press "Ctrl + Break" keys can terminate the current subtest.

The screen should display as previous picture, indicating whether the subtest is passed or failed when finished.

NOTE: The AC adaptor should be connected to successfully run this test.

3.17 LAN Test

The LAN test checks the LAN full-duplex environment.

NOTE: LAN loopback needs to plug in before test begins.

And LAN information will show on the test screen:

- IO Base Port: 3000H
- IRQ AH, it's "IRQ 10".
- Node it is "MAC Address".
- Line Frame 1514 Bytes.
- Line Speed 100Mbps or 10 Mbps.
- ◆ Bus ID it's "4".

The LAN test includes two subtests of the:

- 1. Speed100
 - including Ethernet_802.2, Ethernet_II, Ethernet_SNAP and Ethernet_802.3. All test items are in LSB mode.
- 2. Speed10
 - including Ethernet_802.2 in LSB mode.

The subtests run automatically.

The screen should display as below, indicating whether the subtests pass or fail when finished.

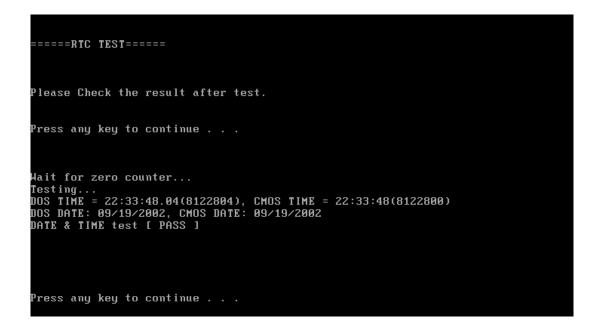
2.N_Hay_Test=false 3.Boot_Rom=false 4.Speed100=true 5.Speed10=true	none none testing
2. Speerin-true	testing
	Press anu keu to ev
	Press any key to ex
Realtek RTL8139(A/B) Fas (c) Copyright 1999, by)	Press any key to ex st Ethernet MLID v3.62 (000112) Realtek Semiconductor Corp. All rights reserve
(c) Copyright 1999, by) Fullduplex environment, Max Frame 1514 bytes, L; Board 1, Frame ETHERNET	st Ethernet MLID v3.62 (000112) Realtek Semiconductor Corp. All rights reserv IRQ 10, Port 3000, Node Address 23F7993AA L ine Speed 100 Mbps, Bus ID 4 802.2. LSB Mode
(c) Copyright 1999, by] Fullduplex environment.	st Ethernet MLID v3.62 (000112) Realtek Semiconductor Corp. All rights reserv IRQ 10, Port 3000, Node Address 23F7993AA L ine Speed 100 Mbps, Bus ID 4 _802.2, LSB Mode _II, LSB Mode

3.18 RTC Test

Checks the computer's RTC (Real Time Clock) and calendar functions by comparing the DOS and CMOS values.

The test runs automatically.

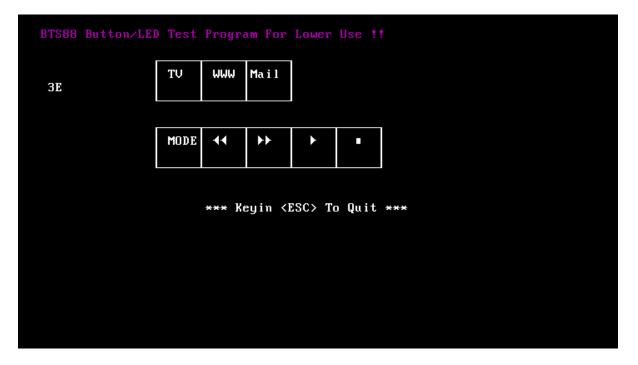
The screen should display as below, indicating whether the test is passed or failed when finished.



3.19 CD Control Button Test

The CD control button test allows the user to manually test each of the five CD control buttons.

The figure below will be displayed:



Press each of the buttons on the front panel in turn. A yellow bar will appear on the relevant section of the figure if the button passes the test.

Press **Esc** to quit the test.

Chapter 4 Replacement Procedures

Chapter 4 Contents

4.1	General
4.2	Battery
4.3	PC Card
4.4	HDD
4.5	Optical Drive Module
4.6	Optical Drive
4.7	Wireless LAN Unit
4.8	Expansion Memory
4.9	Keyboard
4.10	Modem
4.11	Display Assembly
4.12	Touch Cover
4.13	Touch Pad
4.14	Speakers
4.15	System Board
4.16	Fan, Heat Sink, & CPU
4.17	Display Mask
4.18	LCD Module
4.19	FL Inverter Board

Figures

Figure 4-1	Removing the battery pack	4-7
Figure 4-2	Pressing the eject button	4-9
Figure 4-3	Installing the PC Card	4-10
Figure 4-4	HDD	4-11
Figure 4-5	Removing the HDD door	4-11
Figure 4-6	Removing the optical drive module	4-13
Figure 4-7	Removing the optical drive bracket	4-15
Figure 4-8	Removing the mini PCI bracket	4-17
Figure 4-9	Removing the wireless LAN unit	4-18
Figure 4-10	Removing the expansion memory	4-20
Figure 4-11	Removing the expansion memory cover	
Figure 4-12	Installing the expansion memory	
Figure 4-13	Removing the strip cover	
Figure 4-14	Removing the keyboard	4-24
Figure 4-15	Disconnecting the keyboard cable	
Figure 4-16	Removing the modem module	
Figure 4-17	Removing the LCD display cable	
Figure 4-18	Pulling the wireless LAN antenna wires	
Figure 4-19	Removing the top cover-1	4-31
Figure 4-20	Removing the top cover-2	
Figure 4-21	Removing the touch pad	4-34
Figure 4-22	Removing the speakers	4-36
Figure 4-23	Removing the system board-1	4-37
Figure 4-24	Removing the system board-2	
Figure 4-25	Removing the fan module	4-39
Figure 4-26	Removing the heat sink	4-40
Figure 4-27	Removing the CPU	4-40
Figure 4-28	Removing the display mask	
Figure 4-29	Removing the LCD module-1	4-44
Figure 4-30	Removing the LCD module-2	4-45
Figure 4-31	Removing the FL inverter board	4-47

4.1 General

This chapter explains how to disassemble the computer and replace Field Replaceable Units (FRUs). It may not be necessary to remove all the FRUs in order to replace one. The chart below is a guide to which FRUs need to be removed in order to remove others. Always start by removing the battery pack, next, optional items such as the optional PC Card, then follow the chart downward removing only those FRUs necessary to reach the one you think is causing the computer to operate improperly. Refer to the example on the following page.

Battery pack								
Expansion Memory	HDD		Keyboard			Wireless LAN		
Module	ODD		Modem			Display Assembly		
			Fop Cover			Display Ma		
System Boar	rd						LCD Module	
Fan & Heat Sink			t Play Board	Speakers	Touch	Pad	FL Inverter	
CPU						Board		

The example below shows FRUs to be removed before the Direct Play button board can be removed and repaired or replaced. The Direct Play button board is overlapped by the top cover which must be removed before the Direct Play button board can be reached. The removable HDD, keyboard, wireless LAN, ODD, modem, and display assembly in turn overlap the top cover. Always starts the disassembly process by removing the battery pack.

Battery pack							
Expansion Memory	HDD]	Keyboard		Wireless LAN	
Module	ODD			Modem	Di	splay Assembly	
			Fop Cove	r	•	Display Mask	
System Boa					LCD Module		
Fan & Heat Sink		Direct Play Button Board	Speakers	Touch Pa	l FL Inverter		
СРИ						Board	

Safety Precautions

Before you begin disassembly, read the following safety precautions and observe them carefully as you work.

DANGER:

- 1. Always use the lithium ion battery pack or backup battery that is authorized by Toshiba or compatible with the unit. Since other battery packs have different specifications, they may be incompatible with the unit, and may burst or explode. Heating or disassembling the battery pack could cause leakage of alkaline solution. Throwing the battery pack into a fire could cause the battery pack to explode.
- 2. The power supply, FL inverter and other components carry high voltages. To avoid the risk of electric shock when you need to turn on the power of a partially disassembled computer to check its operation, be very careful not to touch connectors or components. Also, do not disassemble individual components in firstlevel maintenance.

WARNING: To avoid the risk of electric shock or other injury:

- 1. Always turn the power off and disconnect the AC adaptor from the power source.
- 2. Remove any metal jewelry or accessories such as necklaces, bracelets, or rings. Batteries in the computer retain an electrical charge so there is danger of electrical shock even when the computer is disconnected from an AC power source.
- 3. Never work with wet or damp hands.
- 4. The computer contains sharp edges and corners: be careful not to injure yourself.
- 5. Make sure that all replacement components meet the specifications for the computer and that all cables and connectors are securely fastened.

CAUTION: To avoid damage to the computer:

- 1. When you change a component, be sure the replacement component meets the required specifications. Never use foreign parts.
- 2. Metal objects such as screws or paper clips which fall into the unit can cause a shortcircuit, fire, or other internal damage.
- 3. When assembling the computer, make sure you use the correct screws to secure the various pieces in place. Screw sizes are listed in their corresponding figure. Make sure all screws are securely fastened. Loose screws can cause short circuits, resulting in heat, smoke, or fire.
- 4. Before removing an FRU or other component, make sure all cables to the component have been disconnected.
- 5. If you use AC power, be sure to use the cable that came with the computer or one recommended by Toshiba.

Before You Begin

Look over the procedures in this section before you begin disassembling the computer. Familiarize yourself with the disassembly and reassembly steps. Begin each procedure by removing the AC adaptor and the battery pack as instructed in section 4.2.

- 1. Do not disassemble the computer unless it is operating abnormally.
- 2. Use only the correct and approved tools.
- 3. Make sure the working environment is free from the following elements whether you are using or storing the computer.
 - Dust and contaminates
 - □ Static electricity
 - Extreme heat, cold and humidity
- 4. Make sure the FRU you are replacing is causing the abnormal operation by performing the necessary troubleshooting and diagnostics tests described in chapters 2 and 3 of this manual.
- 5. Do not perform any operations that are not necessary and use only the described procedures for disassembling and installing FRUs in the computer.
- 6. After removing parts from the computer, place them in a safe place away from the computer so they will not be damaged and will not interfere with your work.
- 7. You will remove and replace many screws when you disassemble the computer. When you remove screws, make sure they are placed in a safe place and identified with the correct parts.
- 8. When assembling the computer make sure you use the correct screws to secure the various pieces. Screw sizes are listed in their corresponding figures.
- 9. The computer contains many sharp edges and corners, so be careful not to injure yourself.
- 10. After you have replaced an FRU, make sure the computer is functioning properly by performing the appropriate test on the FRU you have fixed or replaced.

Disassembly Procedures

The computer has two basic types of cable connectors:

- Pressure Plate Connectors
- □ Standard Pin Connectors

To disconnect a Pressure Plate connector, lift up the tabs on either side of the connector's plastic pressure plate and slide the cable out of the connector. To connect the cable to a Pressure Plate connector, make sure the pressure plate is fully lifted and slide the cable into the connector. Secure the cable in place by pushing the sides of the pressure plate down so the plate is flush with the sides of the connector. Gently pull on the cable to make sure the cable is secure. If you pull out the connector, connect it again making sure the connector's pressure plate is fully lifted when you insert the cable.

Standard pin connectors are used with all other cables. These connectors can be connected and disconnected by simply pulling them apart or pushing them together.

Assembly Procedures

After you have disassembled the computer and fixed or repaired the problem that was causing the computer to operate abnormally, you will need to reassemble the computer.

Install all the removed FRUs following the steps described in the corresponding sections in this chapter.

While assembling the computer, remember the following general points:

- □ Take your time, making sure you follow the instructions closely. Most problems arise when you get in a hurry assembling the computer.
- □ Make sure all cables and connectors are securely fastened.
- □ Before securing the FRU or other parts, make sure that no cables will be pinched by screws or the FRU.
- □ Check that all latches are closed securely.
- □ Make sure all the correct screws are used to secure all FRUs. Using the wrong screw can either damage the threads on the screw or the head of the screw and may prevent proper seating of an FRU.

After installing an FRU in the computer, confirm that the FRU and the computer are functioning properly.

Tools and Equipment

The use of Electrostatic Discharge (ESD) equipment is very important for your safety and the safety of those around you. Proper use of these devices will increase the success rate of your repairs and lower the cost for damaged or destroyed parts. The following equipment is necessary to disassemble and reassemble the computer:

- One M2 Phillips screwdriver to remove and replace screws.
- □ One T5 security screwdriver.
- □ Tweezers, to lift out screws that you cannot grasp with your fingers.
- **ESD** mats for the floor and the table you are working on.
- **ESD** wrist strap or heel grounder.
- □ Anti-static carpeting or flooring.
- □ Air-ionizers in highly static sensitive areas.

4.2 Battery

Removing the Battery Pack

To remove the battery pack from the battery bay, follow the steps below.

- 1. Turn the computer upside down.
- 2. Unlock the battery double lock and slide the battery bay latch to release the battery pack. Then you can remove it from the bay.

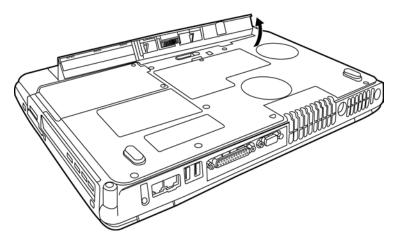


Figure 4-1 Removing the battery pack

NOTE: For environmental reasons, do not throw away a spent battery pack. Please return spent battery packs to Toshiba.

Installing the Battery Pack

To install the battery pack in the battery bay, follow the steps below and refer to the figure in the preceding section.

WARNING: The battery is a lithium ion battery and can explode if not properly replaced, used, handled or disposed of. Use only batteries recommended by Toshiba as replacements.

- 1. Slide the battery pack into the battery bay. The battery bay latch will click automatically.
- 2. Lock the battery double lock to secure the battery pack in position.

4.3 PC Card

Removing a PC Card

To remove a PC Card, follow the steps below.

- 1. Push the PC Card's eject button. The button pops out when you release it.
- 2. Push the eject button once more to pop the PC Card out slightly.
- 3. Grasp the PC Card and remove it.
- 4. Push the eject button back into place, if necessary.

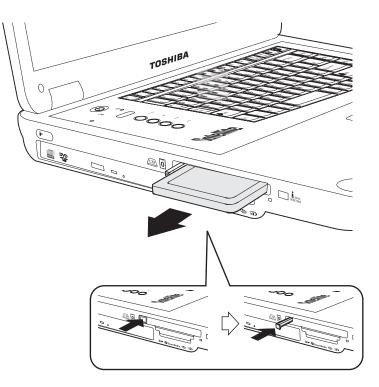


Figure 4-2 Pressing the eject button

Installing the PC Card

To install the PC Card, follow the steps below and refer to the figures in the preceding section.

- 1. Make sure the eject button does not stick out.
- 2. Insert the PC Card and press gently to ensure a firm connection.

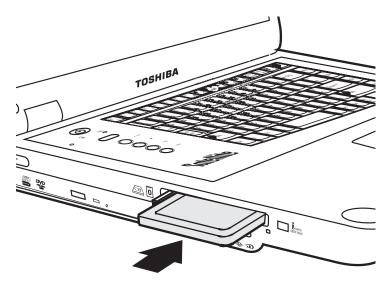


Figure 4-3 Installing the PC card

4.4 HDD

CAUTION: When handling the HDD, do not press the top surface as shown by the arrow. Hold it by the sides.

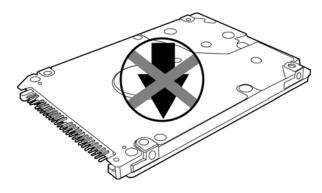


Figure 4-4 HDD

Removing the HDD Module

Follow the steps below to remove HDD module:

- 1. Turn the computer upside down
- 2. Remove two black M2.5x5 screws to release the HDD door.
- 3. Pull out the tab to remove the HDD unit.

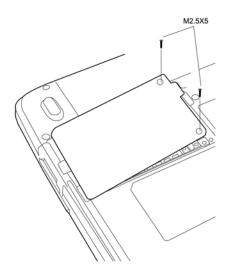


Figure 4-5 Removing the HDD door

- 4. Remove the four M3x3 silver screws that secure the HDD case and bracket to the HDD.
- 5. Remove the HDD from the HDD case.

Installing the HDD

To install the HDD, follow the steps below and refer to the figures in the preceding section.

- 1. Seat the HDD in the HDD case and bracket, and secure it with four $M3 \times 3$ silver screws.
- 2. Insert the HDD unit into the HDD slot.
- 3. Secure the HDD door with two black M2.5x5 screws.

4.5 Optical Drive Module

Removing the Optical Drive Module

To remove the optical drive module, you need to remove the HDD unit first. Follow the steps below:

- 1. Turn the computer upside down.
- 2. Follow the steps above to remove the HDD unit.
- 3. Remove one M2.5x8 screw and slide the optical drive module from the bay.

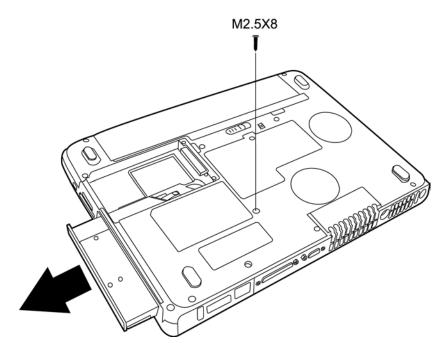


Figure 4-6 Removing the optical drive module

Installing the Optical Drive Module

To install a device in the optical drive module bay, follow the steps below and refer to the figure in the preceding section.

- 1. Slide the device into the optical drive module bay. Use one M2.5x8 screw to secure it in position.
- 2. Slide HDD into the HDD bay.
- 3. Replace the HDD door and use two black M2.5x5 screws to secure it in position.

4.6 Optical Drive

This computer may be fitted with a:

CD-RW/DVD-ROM device DVD-ROM device DVD-R/-RW device DVD+-R/+-RW DVD Super Multi device

Disassembling the Optical Drive

To disassemble the optical drive, first remove the drive from its module bay, then follow the steps below.

- 1. Remove one M2.5x8 screw and slide the optical drive module from the bay.
- 2. Remove two M2x3 screws from the bracket plate. Remove the bracket plate.

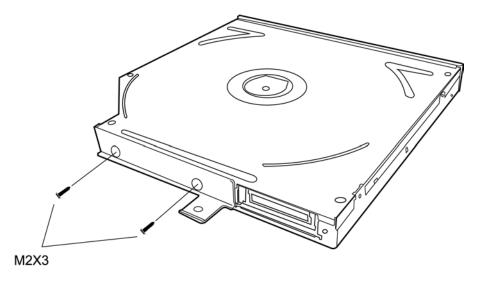


Figure 4-7Removing the optical drive bracket

Reassembling the Optical Drive

To reassemble an optical drive, follow the steps below and refer to the figure in the preceding section.

- 1. Position the optical drive bracket plate to the rear panel of optical drive.
- 2. Secure the optical drive bracket plate with two black M2×3 screws.
- 3. Install the optical drive module into the bay and secure with one M2.5x8 screw.

4.7 Wireless LAN Unit

Removing the Wireless LAN Unit

- 1. Turn the computer upside down and loosen the screw securing the wireless LAN compartment cover.
- 2. Lift off the wireless LAN compartment cover.
- 3. Remove the embedded screw M2.5x5 securing Mini PCI bracket.
- 4. Detach the two ends of the wireless LAN antenna.

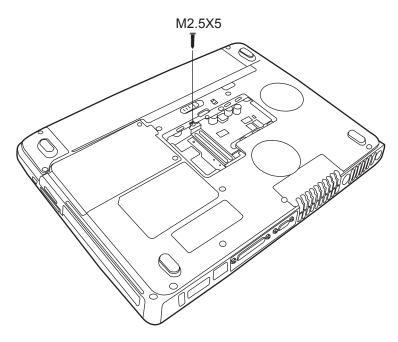


Figure 4-8 Removing the mini PCI bracket

- 5. Gently press out on the latches. One end of the wireless LAN unit will pop up.
- 6. Grasp the wireless LAN unit and pull it out.

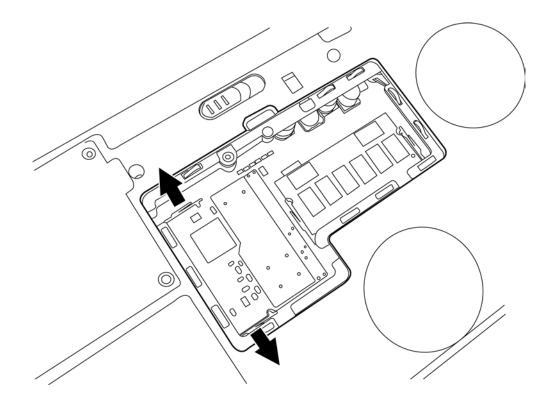


Figure 4-9 Removing the wireless LAN unit

CAUTION: Do not touch the connectors on the wireless LAN unit or on the computer. Debris on the connectors may cause malfunction.

Installing the Wireless LAN Unit

To install the wireless LAN unit, follow the steps below and refer to the figures in the preceding section.

- 1. Turn the computer upside down and loosen the screw securing the wireless LAN compartment cover.
- 2. Lift off the wireless LAN compartment cover.
- 3. Fit the wireless LAN unit's connector to the computer's connectors and press carefully to ensure firm contact.

CAUTION: Do not touch the connectors on the wireless LAN unit or on the computer. Debris on the connectors may cause malfunction.

- 4. Gently, push the wireless LAN unit down until the latches engage the unit to hold it in place.
- 5. Attach the ends of the wireless LAN antenna. The black antenna cable should be attached to the connector near the rear side of the computer, the white antenna cable to the connector closer to the front panel.
- 6. Use the screw M2.5x5 to secure the Mini PCI bracket.
- 7. Seat the wireless LAN compartment cover and secure it with the embedded security screw.

4.8 Expansion Memory

Removing the Expansion Memory

To remove the memory module, make sure the computer is in boot mode then:

- 1. Be sure the power is off and all cables are disconnected from the computer.
- 2. Turn the computer upside down and remove the battery and the screw securing the memory module socket cover.
- 3. Slide your fingernail or a thin object under the cover and lift it off.
- 4. Push the latches to the outside to release the module. A spring will force one end of the module up.
- 5. Grasp the module and pull it out.
- 6. Seat the cover and secure its screws.
- 7. Replace the battery.

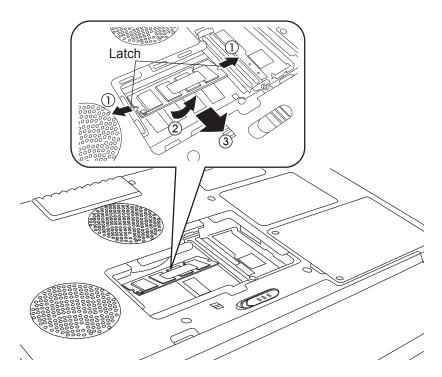


Figure 4-10 Removing the expansion memory

CAUTION: Do not touch the connectors on the expansion memory or on the computer. Debris on the connectors may cause memory access problems.

Installing the Expansion Memory

CAUTION: Do not touch the connectors on the expansion memory or on the computer. Debris on the connectors may cause memory access problems.

Follow these steps to install a memory module:

- 1. Set the computer to boot mode and turn off the power.
 - *a. The computer is turned on.*
 - b. The computer was shut down using the Stand by mode.
 - c. Power to the optical media drive has been turned on by the CD Power switch.
- 2. Remove all cables connected to the computer.
- 3. Turn the computer upside down and remove the battery.
- 4. Remove the screw securing the memory module socket cover.
- 5. Slide your fingernail or a thin object under the cover and lift it off.

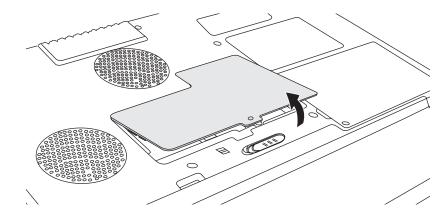


Figure 4-11 Removing the expansion memory cover

6. Fit the module's connectors into the computer's connectors at about a 45 degree angle and press the module carefully to ensure a firm connection.

7. Push the module down so it lies flat. Latches on either side will click into place to secure the module.

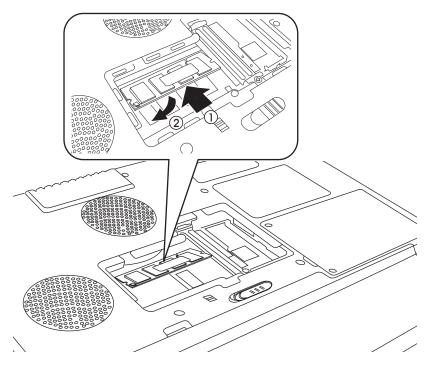


Figure 4-12 Installing the expansion memory

4.9 Keyboard

Removing the Keyboard

Follow the steps below to remove the keyboard:

- 1. Open the display panel.
- 2. Insert a thin tool into the gap between the strip cover and keyboard to lever the strip cover up and then release the strip cover.



Figure 4-13 Removing the strip cover

3. Remove two M2.5 \times 3 black screws securing the keyboard.

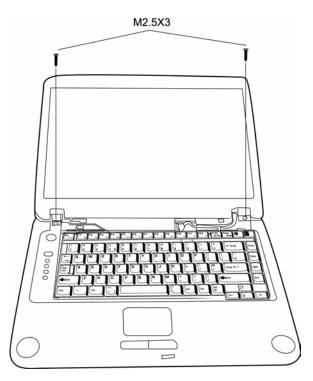


Figure 4-14 Removing the keyboard

- 4. Lift the keyboard out and place over the display hinges, revealing the keyboard cable.
- 5. Disconnect the keyboard cable and remove the keyboard.

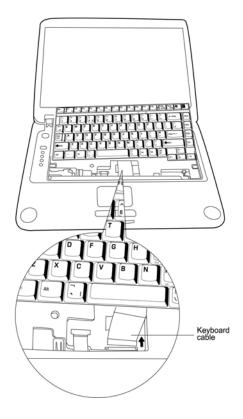


Figure 4-15 Disconnecting the keyboard cable

Installing the Keyboard

To install the keyboard, follow the steps below and refer to the figures in the preceding section.

- 1. Connect the keyboard cable to the system board.
- 2. Set the keyboard in place and secure it with two M2.5x3 black screws.
- 3. Set the strip cover and press down to secure the strip cover latches engage.

4.10 Modem

Removing the Modem

To remove the installed modem, first remove the strip cover and keyboard, then follow the steps below:

- 1. Remove two black M2.5x3 screws securing the modem module
- 2. Carefully lift the unit off its connector
- 3. Disconnect the modem cable from the modem module.

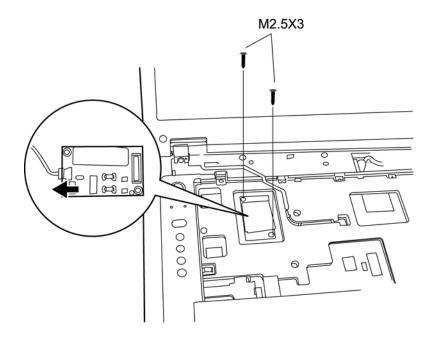


Figure 4-16 Removing the modem module

Installing the Modem

To install a modem, follow the steps below and refer to the figures in the preceding section.

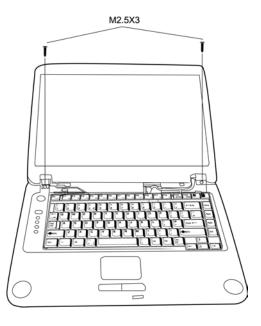
- 1. Fit the modem onto its connector and secure it with two black M2.5x3 screws.
- 2. Connect the modem cable to the modem module.
- 3. Replace the keyboard and strip cover as mentioned in 4.9 Keyboard.

4.11 Display Assembly

Removing the Display Assembly

To remove the display assembly, first remove the keyboard and wireless LAN, then follow the steps below:

1. Remove the strip cover and then remove the two black screws M2.5x3 securing the keyboard.



- 2. Disconnect the LCD power cable from the top chassis.
- 3. Remove one M2.5x3 black screw securing LCD display cable then unplug the cable.

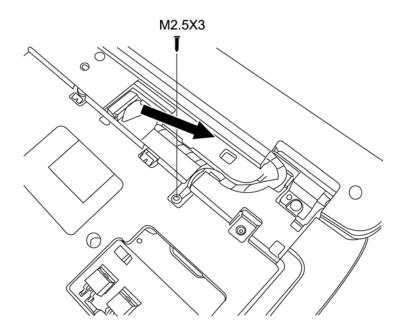


Figure 4-17 Removing the LCD display cable

4. Pull the wireless LAN module's antenna wires through the small hole beside the LCD display cable connector.

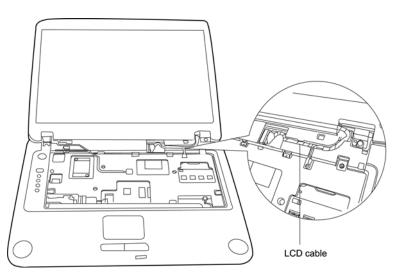


Figure 4-18 Pulling the wireless LAN antenna wires

- 5. Remove two M2.5x8 black screws from each hinge and two black M2.5x8 black screws from the computer's back side which help hold the display assembly in place.
- 6. Lift the display assembly from the computer's chassis.

Installing the Display Assembly

To install the display assembly, follow the steps below and refer to the figures in the preceding section.

- 1. Seat the display assembly taking care not to crush to the LCD display cable, the LCD power cable, or wireless LAN antenna.
- 2. Secure two M2.5x8 black screws to each hinge and two black M2.5x8 black screws to the computer's back side (which help hold the display assembly in place).
- 3. Feed the wireless LAN module's antennae wires through the small hole beside the LCD display cable connector.
- 4. Connect the LCD power cable to the top chassis.
- 5. Connect the LCD display cable and secure it with one M2.5x3 black screw.
- 6. Reinstall the keyboard and wireless LAN module.

4.12 Top Cover

Removing the Cover

To remove the top cover, first remove the battery pack, display assembly, optical drive module, HDD, memory module and wireless LAN as described in the preceding sections, then follow the steps below:

1. Remove five black M2.5x8 black screws and one black M2.5x3 screw securing the top cover.

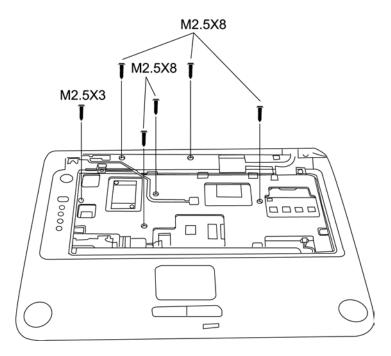


Figure 4-19 Removing the top cover-1

- 2. Detach the upper FFC cable and two speaker cables on the top chassis.
- 3. Remove the two black M2.5x8 screws securing the system board.
- 4. Turn the computer upside down and remove the following sixteen screws:

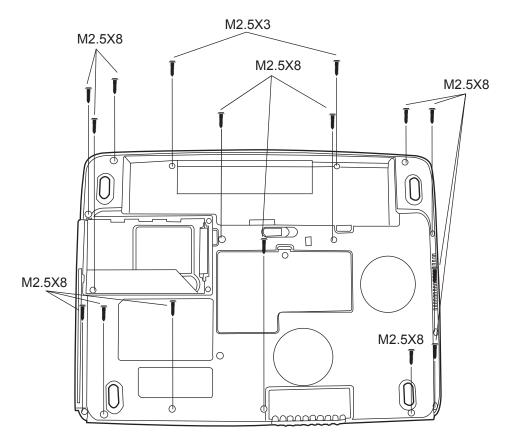


Figure 4-20 Removing the top cover-2

5. Turn the computer upright to lift off the top cover.

Installing the Top Cover

To install the top cover, follow the steps below and refer to the figures in the preceding section.

- 1. Seat the top cover and secure the upper FFC cable and two speaker cables to the computer's top chassis.
- 2. Secure the top cover with five black M2.5x8 and one M2.5x3 black screws.
- 3. Turn the computer upside down and secure the sixteen screws.

4.13 Touch Pad

Removing the Cover

To remove the Touch Pad, first remove the top cover, then follow the steps below:

- 1. Disconnect the Touch Pad LED board FFC cable from the Touch Pad.
- 2. Remove one M2.5x3 screw securing the Track Pad Bracket. Lift out the Track Pad Bracket.
- 3. Remove twoM2.5x3 silver screws securing the LED PCB board. Lift it out.

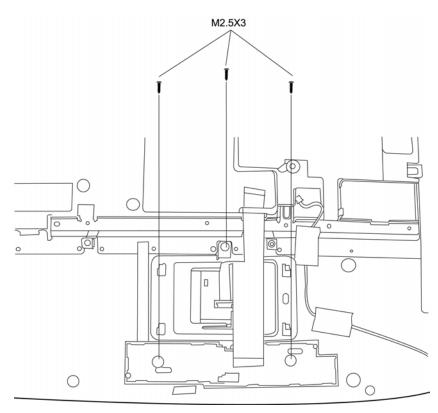


Figure 4-21 Removing the touch pad

Installing the Touch Pad

To install the Touch Pad, follow the steps below and refer to the figures in the preceding section:

- 1. With the top cover upside down, place the Touch Pad, the Track Pad Bracket, and LED PCB board in position.
- 2. Secure the LED PCB board with two M2.5x3 silver screws.
- 3. Secure Track Pad Bracket with one M2.5x3 screw.
- 4. Connect the Touch Pad LED board FFC cable to the Touch Pad.

4.14 Speakers

Removing the Speakers

To remove the speakers, first remove the top cover, then follow the steps below:

1. Remove the four M2x3 screws and then disconnect the speaker cables from the right and left speakers.

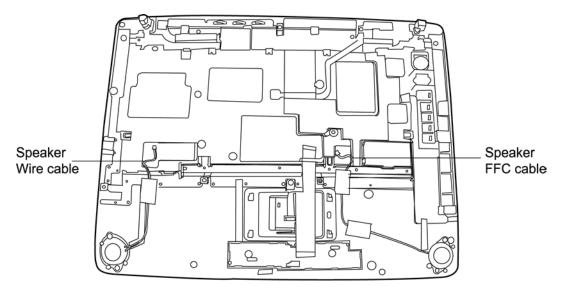


Figure 4-22 Removing the speakers

2. Lift out the speakers.

Installing the Speakers

To install the speakers, follow the steps below and refer to the figure in the preceding section:

- 1. Seat each speaker. The speaker cases are marked with L (left) and R (right).
- 2. Secure each speaker with two M2x3 screws.
- 3. Attached the left- and right-side speaker cables to the system board.
- 4. Reassemble the rest of the computer.

4.15 System Board

Removing the System Board

To remove the system board, first remove the LCD assembly and top cover, then follow the steps below:

1. Remove the two black M2.5x8 screws securing the system board to the bottom cover.

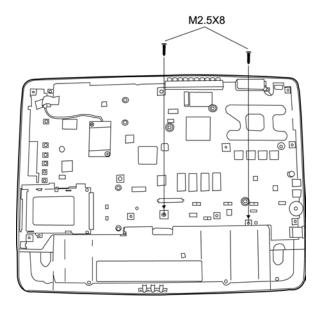


Figure 4-23 Removing the system board-1

2. Remove the two or four silver screws securing the system board to the backside.

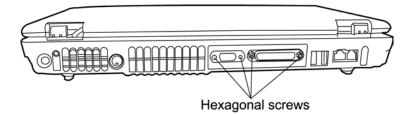


Figure 4-24 Removing the system board-2

3. Remove the system board from the chassis.

Installing the System Board

To install the system board, follow the steps below and refer to the figures in the preceding section.

- 1. Seat the system board in the chassis and secure it with two black M2.5x8 screws.
- 2. Reassemble the computer.

4.16 Fan, Heat Sink, & CPU

Removing the Fan, Heat Sink & CPU

To remove the Fan, Heat Sink, and CPU, you must first remove the panel, keyboard, top cover and bottom chassis to reveal the system board, then follow the steps below:

1. Turn the system board upside down and remove the four embedded security screws securing the fan module. Remove the two fan connectors from the system board. Then you can remove the fan module.

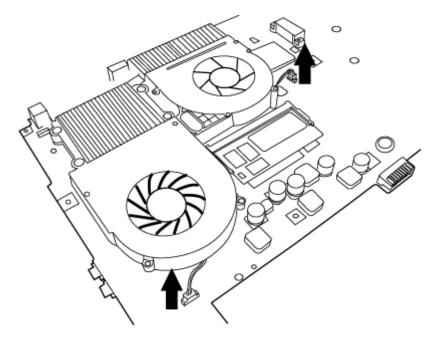


Figure 4-25 Removing the fan module

2. Remove the four embedded screws securing the heat sink in the order indicated on the heat sink. Then Lift out the heat sink while preventing the stress on the CPU below.

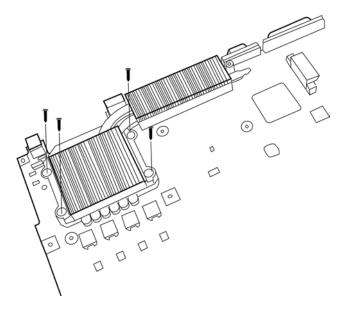


Figure 4-26 Removing the heat sink

- 3. Turn the cam on the CPU socket with a flat-blade screwdriver so that the notch on the cam is aligned with the *open* side of the CPU socket to unlock the CPU.
- 4. Gently lift out the CPU.

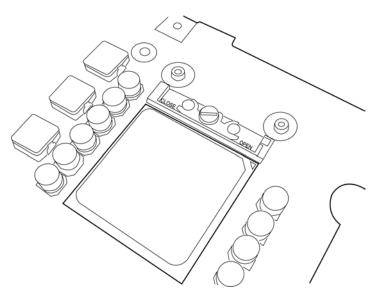


Figure 4-27 Removing the CPU

Installing the CPU

To install the CPU, follow the steps below and refer to the figures in the preceding section.

CAUTION: If you remove the heat sink, you should use the CPU grease tool to remove the grease on the CPU and heat sink. Reapply fresh grease before installing the heat sink.

- 1. Make sure that the notch on the cam is aligned with the *open* position.
- 2. Seat the CPU to align the triangle mark on the CPU with the one on the CPU socket. Make sure the alignment is exact to avoid damaging pins on the CPU.
- 3. Press the CPU softly with your fingers and turn the cam on the CPU socket to the *closed* position with a flat-blade screwdriver to secure the CPU.
- 4. Seat the heat sink over the CPU and secure with four screws in the order indicated on the heat sink.
- 5. Seat the fan module and secure with four embedded screws.
- 6. Attach the two fan connectors.

4.17 Display Mask

Removing the Display Mask

To remove the display mask, first remove the display assembly as described earlier, then follow the steps below:

- 1. Remove the mask seals to expose two lower inner corner screws securing the display mask.
- 2. Remove two M2.5×5 black screws from the corners that were previously covered by the mask seals.
- 3. Carefully insert your fingers between the mask and the LCD panel and pry open the snaps. Start with the four snaps at the top of the display mask. Continue unsnapping the display mask along the two sides and the bottom edge to remove display.

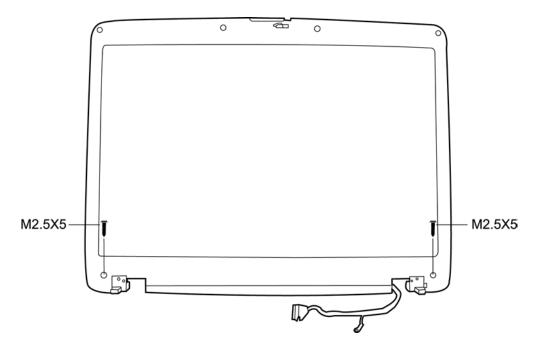


Figure 4-28 Removing the display mask

Installing the Display Mask

To install the display mask, follow the steps below and refer to the figures in the preceding section.

- 1. Seat the display mask and secure the snaps on each side.
- 2. Secure the display mask with two M2.5x5 screws at the bottom inner corner.
- 3. Cover the secured screws with mask seals.

4.18 LCD Module

Removing the LCD Module

To remove the LCD module, first remove the display assembly and display mask, then follow the steps below.

- 1. Remove two M2x3 black screws securing the LCD cable and FL inverter board.
- 2. Disconnect the LCD cable from the FL inverter board.
- 3. Remove two M2.5x5 black screws securing the LCD module bracket to LCD cover.

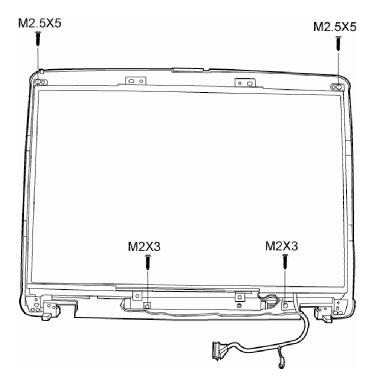


Figure 4-29 Removing the LCD module-1

4. Remove six M2x3 screws securing LCD module bracket to LCD module. Remove LCD cable.

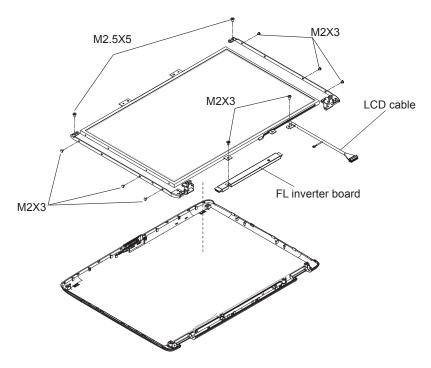


Figure 4-30 Removing the LCD module-2

5. Remove the LCD module.

NOTE: If the LCD module malfunctions, remove the LCD cable and LCD bracket. Then replace the whole LCD module unit.

Installing the LCD Module

To install the LCD module, follow the steps below and refer to the figures in the preceding section.

- 1. Set the LCD module in the display assembly.
- 2. Connect the FL cable and the HV cable to the FL inverter board.
- 3. Seat the LCD module in the display assembly with the LCD module bracket and six M2x3 black screws. Secure the LCD module with M2.5x5 black screws.
- 4. Secure two M2x3 black screws holding the left HV cable and FL inverter board in place.

4.19 FL Inverter Board

Removing the FL Inverter Board

To remove the FL inverter board, first remove the battery pack, the display assembly, display mask, and LCD module, then follow the steps below.

1. Remove one M2x3 black screw securing the FL invert board to the LCD display assembly.

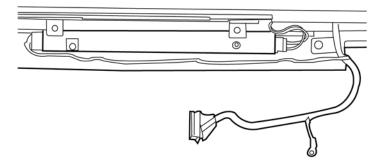


Figure 4-31 Removing the FL inverter board

Installing the FL Inverter Board

To install the FL inverter board, follow the steps below and refer to the figure in the preceding section..

- 1. Secure one M2x3 black screw connecting the FL inverter board to the LCD display assembly.
- 2. Reassemble the computer.

Appendices

Appendix Contents

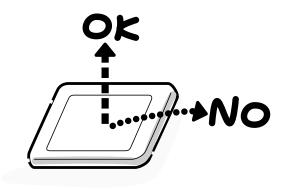
Appe	ndix A Handling the LCD Module	
Anne	ndix B Board Layout	B_1
B.1	System Board (FRDSY*) Bottom View	
B.2	System Board (FRDSY*) Top View	
2.2		
Appe	ndix C Pin Assignments	C-1
C.1	JP23/JP24 SODIMM I/F (200-PIN)	C-1
C.2	JP1/JP2 LCD I/F (22-pin)	C-5
C.3	JP14 RGB I/F (15-pin)	C-6
C.4	JP10 HDD I/F (44-pin)	C-7
C.5	JP28 ODD Module I/F (60-pin)	C-8
C.6	JP13 Parallel I/F (25-pin)	C-9
C.7	JP26 PC Card I/F (84-pin)	C-10
C.8	JP19, JP22 Fan I/F (3-pin)	C-14
C.9	PCN1 AC Adaptor Connector (3-pin)	C-14
C.10	JP29 LINE IN (6-pin)	C-14
C.11	JP30 Microphone (6-pin)	C-15
C.12	JP31 Headphone (6-pin)	C-15
C.13	JP31 Headphone Connector (6-pin)	C-15
C.14	JP29 LINE-IN Connector (6-pin)	C-15
Appe	ndix D Keyboard Scan/Character Codes	D-1
Appe	ndix E Key Layout	E-1
E.1	United States (US) Keyboard	E-1
E.2	United Kingdom (UK) Keyboard	E-1
E.3	Spanish (SP) Keyboard	E-2
E.4	Japanese (JA) Keyboard	E-2
E.5	Korean (KO) Keyboard	E-3
E.6	Korean (CF) Keyboard	E-3
E.7	Portuguese-ALPS Keyboard	E-4

Appendix A Handling the LCD Module

Precautions for handling the LCD module

The LCD module can be easily damaged during assembly or disassembly. Therefore, please observe the following precautions when handling it:

1. When installing the LCD module in the LCD cover, be sure to seat it so that it is properly aligned and maximum visibility of the display is maintained.



2. Be careful to align the holes at the four corners of the LCD module with the corresponding holes in the LCD cover before securing the module with screws. Do not force the module into place, because stress can affect its performance.

Note: The panel's polarized surface is easily scarred, so handle it carefully.





3. If the panel's surface gets dirty, wipe it with cotton or a soft cloth. If it is still dirty, try breathing on the surface to create a light condensate and wipe it again.

If the surface is very dirty, we recommend a CRT cleaning agent. Apply the agent to a cloth and then wipe the panel's surface. Do not apply cleanser directly to the panel.



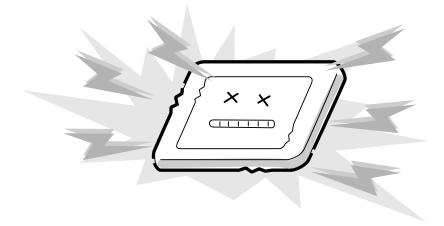
4. If water or other liquid is left on the panel's surface for a long period, it can change the screen's tint or stain it. Be sure to quickly wipe off any liquid.



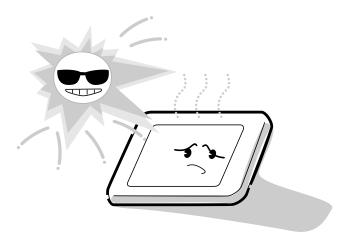
5. Glass is used in the panel, so be careful not to drop it or let it strike a hard object, which could cause breakage or cracks.



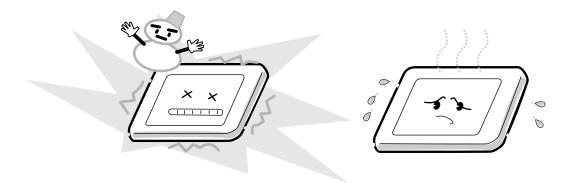
6. CMOS-LSI circuits are used in the module, so guard against damage from electrostatic discharge. Be sure to wear a wrist or ankle ground when handling the module.



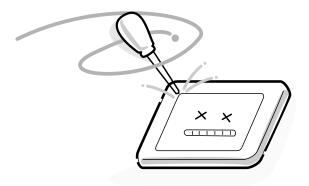
7. Do not expose the module to direct sunlight or strong ultraviolet rays for long periods.



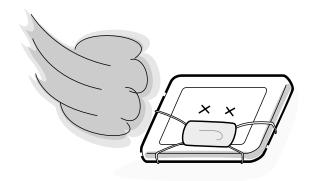
8. Do not store the module at temperatures below specifications. Cold can cause the liquid crystals to freeze, lose their elasticity or otherwise suffer damage.



9. Do not disassemble the LCD module. Disassembly can cause malfunctions.



10. If you transport the module, do not use packing material that contains epoxy resin (amine) or silicon glue (alcohol or oxime). These materials can release gas that can damage the panel's polarization.



E.8	US-INTE_ALPS Keyboard	E-4
E.9	Greece(GR) Keyboard	E-5
E.10	France (FR) Keyboard	E-5
E.11	Chinese (CH) Keyboard	E -6
E.12	Swissc-Darfon Keyboard	E -6
E.13	IT new Keyboard	E -7
Appen	dix F Series Screw Torque ListI	F -1
Appen	dix G Reliability	J-1

Figures

Figure B-1	System board (FRDSY*) layout (Bottom)	B-1
Figure B.2	System board (FRDSY*) layout (Top)	B-2
Figure E-1	US keyboard	E-1
Figure E-2	UK keyboard	E-1
Figure E-3	SP keyboard	E-2
Figure E-4	JA keyboard	E-2
Figure E-5	KO keyboard	E-3
Figure E-6	CF keyboard	E-3
Figure E-7	Portuguese-ALPS keyboard	E-4
Figure E-8	US-INTE_ALPS Keyboard	E-4
Figure E-9	GR keyboard	E-5
Figure E-10	FR keyboard	E-5
Figure E-11	CH keyboard	E-6
Figure E-12	Swissc-Darfon keyboard	E-6
Figure E-13	IT new keyboard	E-7

Tables

Table B-1	System board ICs (top and bottom)	B-3
Table B-2	System board connectors (top and bottom)	B-4
Table C-1	SODIMM I/F pin assignments (200-PIN)	C-1
Table C-2	LCD I/F pin assignments (22-pin)	C-5
Table C-3	RGB I/F pin assignments (15-pin)	C-6
Table C-4	HDD I/F pin assignments (44-pin)	C-7
Table C-5	ODD I/F pin assignments (50-pin)	C-8
Table C-6	Parallel I/F pin assignments (25-pin)	C-9
Table C-7	PC Card I/F pin assignments (84-pin)	C-10
Table C-8	Mini PCI I/F pin assignments (124-pin)	C-12
Table C-9-1	JP18 Fan I/F pin assignments (3-pin)	C-14
Table C-9-2	JP21 Fan I/F pin assignments (3-pin)	C-14
Table C-10	AC Adaptor Connector pin assignments (3-pin)	C-14
Table C-11	Line in I/F pin assignments (6-pin)	C-14
Table C-12	Microphone I/F pin assignments (6-pin)	C-15
Table C-13	Microphone I/F pin assignments (6-pin)	C-15
Table C-14	Headphone Connector pin assignments (6-pin)	C-15
Table C-15	Headphone Connector pin assignments (6-pin)	C-15
Table D-1	Scan codes (set 1 and set 2)	D-1
Table D-2	Scan codes with left Shift key	D-5
Table D-3	Scan codes in Numlock mode	D-6
Table D-4	Scan codes with Fn key	D-6
Table D-5	Scan codes in overlay mode	D-7
Table D-6	No.124 key scan code	D-7
Table D-7	No.126 key scan code	D-8
Table F-1	Series Screw Torque List	F-1
Table G-1	MTBF	G-1

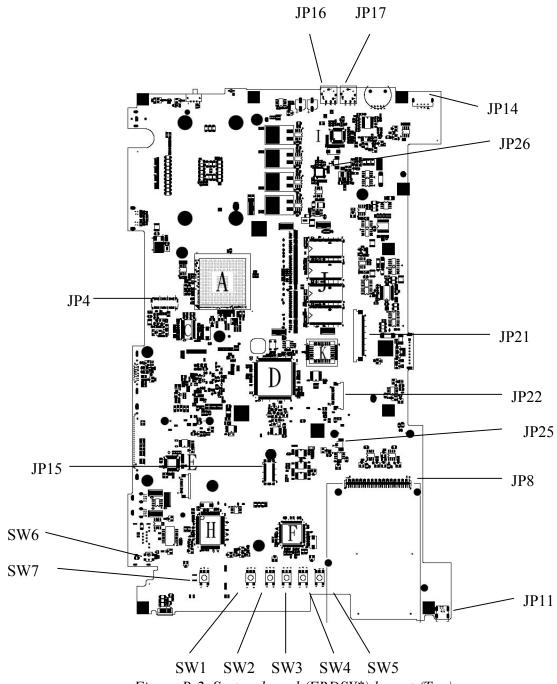
Appendix B Board Layout

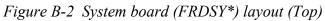
JP27 JP10 JP13 JP19 JP7 JP6 JP12 JP5 JP23 PJP2 JP3-JP2 JP1 JP24 PJP1

B.1 System Board (FRDSY*) Bottom View

Figure B-1 System board (FRDSY*) layout (Bottom)

B.2 System Board (FRDSY*) Top View





Mark	Number	Name
А	U51	ATI RC300ML
В	U14	ATI IXP150
С	U11	CLK GEN ICS951402AGT
D	U39	KB/EC KB910Q
E	U37	I/O Controller (LPC47N217-JN)
F	U27	IEEE1394A_TSB43AB21A
G	U21	Cardbus & 5-in-1 Card Reader ENE CB714
Н	U24	LAN controller RTL8100CL
Ι	U32	AC97 CODEC ALC250
J	U3,U4,U5,U6,U7,U8,U9,U10	On Board RAM
K	U41	BIOS ROM512K8-90

Table B-1 System board ICs (top and bottom)

JP1CPU SocketJP2TV-OUT ConnectorJP3SODIMM SocketJP4LVDS ConnectorJP5CRT ConnectorJP6HDD ConnectorJP7ODD Connector	
JP3SODIMM SocketJP4LVDS ConnectorJP5CRT ConnectorJP6HDD Connector	
JP4LVDS ConnectorJP5CRT ConnectorJP6HDD Connector	
JP5 CRT Connector JP6 HDD Connector	
JP6 HDD Connector	
JP7 ODD Connector	
JP8 CARDBUS Socket	
JP10 RJ11/RJ45 Connector	
JP11 1394 Connector	
JP12 MINI PCI	
JP13, JP14 USB Connector	
JP15 MDC Connector	
JP16 MICROPHONE IN JACK Connector	
JP17 HEADPHONE OUT JACK Connector	
JP19 Parallel Connector	
JP21 Keyboard Connector	
JP22 Touch Pad Connector	
JP23,JP24 FAN Connector	
JP25,JP26 Speaker Connector	
JP27 5-IN-1 Cardreader Connector	
SW1 CD-PLAY Button	
SW2 Reverse Button	

Table B-2 System board connectors (top and bottom)

SW3	Forward Button
SW4	Play Button
SW5	Stop Button
SW6	LID Switch
SW7	Power Button
PJP1	DC-in Connector
РЈР2	Battery Connector

Appendix C Pin Assignments

System Board

C.1 JP3

Pin No.	Signal name	I/O	Pin No.	Signal Name	I/O
1	VREF	0	2	VREF	0
3	VSS	-	4	VSS	-
5	DQ0	I/O	6	DQ4	I/O
7	DQ1	I/O	8	DQ5	I/O
9	25VDD	0	10	2.5VDD	0
11	DQS0	I/O	12	DM0	0
13	DQ2	I/O	14	DQ6	I/O
15	VSS	-	16	VSS	-
17	DQ3	I/O	18	DQ7	I/O
19	DQ8	I/O	20	DQ12	I/O
21	2.5VDD	0	22	2.5VDD	0
23	DQ9	I/O	24	DQ13	I/O
25	DQS1	I/O	26	DM1	0
27	VSS	-	28	VSS	-
29	DQ10	I/O	30	DQ14	I/O
31	DQ11	I/O	32	DQ15	I/O
33	2.5VDD	0	34	2.5VDD	0
35	CK0	0	36	2.5VDD	0
37	CK0#	0	38	VSS	-
39	VSS	-	40	VSS	-
41	DQ16	I/O	42	DQ20	I/O
43	DQ17	I/O	44	DQ21	I/O
45	2.5VDD	0	46	2.5VDD	0
47	DQS2	I/O	48	DM2	0
49	DQ18	I/O	50v	DQ22	I/O

Table C-1 SODIMM I/F pin assignments (200-PIN) (1/4)

Pin No.	Signal name	I/O	Pin No.	Signal Name	I/O
51	VSS	-	52	VSS	-
53	DQ19	I/O	54	DQ23	I/O
55	DQ24	I/O	56	DQ28	I/O
57	2.5VDD	0	58	2.5VDD	0
59	DQ25	I/O	60	DQ29	I/O
61	DQS3	I/O	62	DM3	0
63	VSS	-	64	VSS	-
65	DQ26	I/O	66	DQ30	I/O
67	DQ27	I/O	68	DQ31	I/O
69	2.5VDD	0	70	2.5VDD	0
71	CB0	-	72	CB4	-
73	CB1	-	74	CB5	-
75	VSS	-	76	VSS	-
77	DQS8	-	78	DM8	-
79	CB2	-	80	CB6	-
81	2.5VDD	0	82	2.5VDD	0
83	CB3	-	84	CB7	-
85	DU	-	86	DU/RESET#	-
87	VSS	-	88	VSS	-
89	CK2	-	90	VSS	-
91	CK2#	-	92	2.5VDD	0
93	2.5VDD	0	94	2.5VDD	0
95	CKE1	-	96	CKE0	0
97	DU/A13	-	98	DU/BA2	-
99	A12	-	100	A11	0
101	A9	0	102	A8	0
103	VSS	-	104	VSS	-
105	A7	0	106	A6	0
107	A5	0	108	A4	0
109	A3	0	110	A2	0
111	A1	0	112	A0	0
113	2.5VDD	0	114	2.5VDD	0

Table C-1 SODIMM I/F pin assignments (200-PIN) (2/4)

Pin No.	Signal name	I/O	Pin No.	Signal Name	I/O
115	A10/AP	0	116	BA1	0
117	BA0	Ο	118	RAS#	0
119	WE#	Ο	120	CAS#	0
121	SO#	Ο	122	S1#	-
123	DU	-	124	DU	-
125	VSS	-	126	VSS	-
127	DQ32	I/O	128	DQ36	I/O
129	DQ33	I/O	130	DQ37	I/O
131	2.5VDD	Ο	132	2.5VDD	0
133	DQS4	I/O	134	DM4	0
135	DQ34	I/O	136	DQ38	I/O
137	VSS	-	138	VSS	-
139	DQ35	I/O	140	DQ39	I/O
141	DQ40	I/O	142	DQ44	I/O
143	2.5VDD	0	144	2.5VDD	0
145	DQ41	I/O	146	DQ45	I/O
147	DQS5	I/O	148	DM5	0
149	VSS	-	150	VSS	-
151	DQ42	I/O	152	DQ46	I/O
153	DQ43	I/O	154	DQ47	I/O
155	2.5VDD	0	156	2.5VDD	0
157	2.5VDD	0	158	CK1#	0
159	VSS	-	160	CK1	0
161	VSS	-	162	VSS	-
163	DQ48	I/O	164	DQ52	I/O
165	DQ49	I/O	166	DQ53	I/O
167	2.5VDD	0	168	2.5VDD	0
169	DQS6	I/O	170	DM6	0
171	DQ50	I/O	172	DQ54	I/O
173	VSS	-	174	VSS	-
175	DQ51	I/O	176	DQ55	I/O
177	DQ56	I/O	178	DQ60	I/O
179	2.5VDD	0	180	2.5VDD	0

Table C-1 SODIMM I/F pin assignments (200-PIN) (3/4)

Pin No.	Signal name	I/O	Pin No.	Signal Name	I/O
181	DQ57	I/O	182	DQ61	I/O
183	DQS7	I/O	184	DM7	0
185	VSS	-	186	VSS	-
187	DQ58	I/O	188	DQ62	I/O
189	DQ59	I/O	190	DQ63	I/O
191	2.5VDD	Ο	192	2.5VDD	0
193	SDA	I/O	194	SA0	0
195	SCL	0	196	SA1	0
197	3.3VDD_SPD	0	198	SA2	0
199	VDD_ID	0	200	DU	-

Table C-1 SODIMM I/F pin assignments (200-PIN) (4/4)

Pin No.	Signal name	I/O	Pin No.	Signal Name	I/O
1	CRT_R	0	2	CRT_G	0
3	CRT_B	0	4	NC	-
5	GND	-	6	GND	-
7	GND	-	8	GND	-
9	+CRT_VCC	-	10	GND	-
11	NC	-	12	DDC_DATA	I/O
13	DACA_HSYNC	0	14	DACA_VSYNC	0
15	DDC_CLK	I/O			

Table C-3 RGB I/F pin assignments (15-pin)

Pin No.	Signal name	I/O	Pin No.	Signal Name	I/O
1	PIDE-RST#	0	2	GND	-
3	PDD7	I/O	4	PDD8	I/O
5	PDD6	I/O	6	PDD9	I/O
7	PDD5	I/O	8	PDD10	I/O
9	PDD4	I/O	10	PDD11	I/O
11	PDD3	I/O	12	PDD12	I/O
13	PDD2	I/O	14	PDD13	I/O
15	PDD1	I/O	16	PDD14	I/O
17	PDD0	I/O	18	PDD15	I/O
19	GND	-	20	NC	-
21	PDDREQ	I	22	NC	-
23	PDIOW#	0	24	GND	-
25	PDIOR#	0	26	GND	-
27	PDIORDY	I	28	PCSEL	0
29	PDDACK#	0	30	GND	-
31	IRQ14	I	32	NC	-
33	PDA1	0	34	NC	-
35	PDA0	0	36	PDA2	0
37	PDCS1#	0	38	PDCS3#	0
39	PHDD_LED#	I	40	GND	-
41	+5VS	-	42	+5VS	-
43	GND	-	44	NC	-

Table C-4 HDD I/F pin assignments (44-pin)

Pin No.	Signal name	I/O	Pin No.	Signal Name	I/O
1	INT_CD_L	I	2	INT_CD_R	I
3	CD_AGND	-	4	GND	-
5	SIDE_RST#	0	6	SDD8	I/O
7	SDD7	I/O	8	SDD9	I/O
9	SDD6	I/O	10	SDD10	I/O
11	SDD5	I/O	12	SDD11	I/O
13	SDD4	I/O	14	SDD12	I/O
15	SDD3	I/O	16	SDD13	I/O
17	SDD2	I/O	18	SDD14	I/O
19	SDD1	I/O	20	SDD15	I/O
21	SDD0	I/O	22	SDDREQ	I
23	GND	-	24	SDIOR#	0
25	SDIOW#	0	26	GND	0
27	SIORDY	I	28	SDDACK#	0
29	IRQ15	I	30	NC	0
31	SDA1	0	32	+5VCD	I
33	SDA0	0	34	SDA2	I
35	SDCS1#	0	36	SDCS3#	-
37	SHDD_LED#	I	38	+5VCD	0
39	+5VCD	-	40	+5VCD	-
41	+5VCD	-	42	+5VCD	-
43	GND	-	44	GND	-
45	GND	-	46	GND	-
47	GND	-	48	GND	-
49	NC	-	50	NC	-

 Table C-5 ODD I/F pin assignments (50-pin)

Pin No.	Signal name	I/O	Pin No.	Signal Name	I/O
1	STROB	0	2	PDB00	I/O
3	PDB01	I/O	4	PDB02	I/O
5	PDB03	I/O	6	PDB04	I/O
7	PDB05	I/O	8	PDB06	I/O
9	PDB07	I/O	10	ACK	I
11	BUSY	I	12	PE	I
13	SELCT	I	14	AUTFD	0
15	ERROR	I	16	PINIT	0
17	SLIN	0	18	GND	-
19	GND	-	20	GND	-
21	GND	-	22	GND	-
23	GND	-	24	GND	-
25	GND	-			

Table C-6 Parallel I/F pin assignments (25-pin)

Pin No.	Signal name	I/O	Pin No.	Signal Name	I/O
1	GND	-	2	GND	-
3	S1_D3	I/O	4	S1_CD1#	0
5	S1_D4	I/O	6	S1_D11	I/O
7	S1_D5	I/O	8	S1_D12	I/O
9	S1_D6	I/O	10	S1_D13	I/O
11	S1_D7	I/O	12	S1_D14	I/O
13	S1_CE1#	I/O	14	S1_D15	I/O
15	S1_A10	I	16	S1_CE2#	I/O
17	S1_OE#	I/O	18	S1_VS1	I
19	S1_A11	I	20	S1_IORD#	I/O
21	S1_A9	I	22	S1_IOWR#	I
23	S1_A8	I	24	S1_A17	I
25	S1_A13	I	26	S1_A18	I
27	S1_A14	I	28	S1_A19	I
29	S1_WE#	I	30	S1_A20	I
31	S1_RDY#	0	32	S1_A21	I
33	+S1_VCC	-	34	+S1_VCC	-
35	+S1_VPP	-	36	+S1_VPP	-
37	S1_A16	I	38	S1_A22	I
39	S1_A15	I	40	S1_A23	I
41	S1_A12	I	42	S1_A24	I
43	S1_A7	I	44	S1_A25	I
45	S1_A6	I	46	S1_VS2	I
47	S1_A5	I	48	S1_RST	I
49	S1_A4	I	50	S1_WAIT#	I
51	S1_A3	I	52	S1_INPACK#	0
53	S1_A2	I	54	S1_REG#	I
55	S1_A1	I	56	S1_BVD2	0
57	S1_A0	I	58	S1_BVD1	I
59	S1_D0	I	60	S1_D8	I/O

Table C-7 PC Card I/F pin assignments (84-pin) (1/2)

Pin No.	Signal name	I/O	Pin No.	Signal Name	I/O
61	S1_D1	I/O	62	S1_D9	I/O
63	S1_D2	I/O	64	S1_D10	I/O
65	S1_WP	I/O	66	S1_CD2#	I
67	GND	-	68	GND	-
69	GND	-	70	GND	-
71	GND	-	72	GND	-
73	GND	-	74	GND	-
75	GND	-	76	GND	-
77	GND	-	78	GND	-
79	GND	-	80	GND	-
81	GND	-	82	GND	-
83	GND	-	84	GND	-

Table C-7 PC Card I/F pin assignments (84-pin) (2/2)

Pin No.	Signal name	I/O	Pin No.	Signal Name	I/O
1	NC	-	2	NC	-
3	NC	-	4	NC	-
5	NC	-	6	NC	-
7	NC	-	8	NC	-
9	NC	-	10	NC	-
11	NC	-	12	NC	-
13	SWITCH	0	14	NC	-
15	NC	-	16	NC	-
17	PIRQH#	I	18	+5VS_MINIPCI	-
19	+3.3V	0	20	PIRQG#	I
21	NC	-	22	NC	-
23	GND	-	24	+3.3V	0
25	PCICLK	0	26	PCIRST#	0
27	GND	-	28	+3.3V	0
29	REQ1#	I	30	GNT1#	0
31	+3.3V	0	32	GND	-
33	AD31	I/O	34	WLANME#	I
35	AD29	I/O	36	NC	-
37	GND	-	38	AD30	I/O
39	AD27	I/O	40	+3.3V	0
41	AD25	I/O	42	AD28	I/O
43	NC	-	44	AD26	I/O
45	CBE3#	I/O	46	AD24	I/O
47	AD23	I/O	48	MINI_IDSEL	I/O
49	GND	-	50	GND	-
51	AD21	I/O	52	AD22	I/O
53	AD19	I/O	54	AD20	I/O
55	GND	-	56	PAR	I/O
57	AD17	I/O	58	AD18	I/O
59	CBE2#	I/O	60	AD16	I/O

Table C-8 Mini PCI I/F pin assignments (124-pin) (1/2)

Pin No.	Signal name	I/O	Pin No.	Signal Name	I/O
61	IRDY#	I/O	62	GND	-
63	+3.3V	0	64	FRAME#	I/O
65	PM_CLKRUN#	I/O	66	TRDY#	I/O
67	PCI_SERR#	I/O	68	STOP#	I/O
69	GND	-	70	+3.3V	0
71	PCI_PERR#	0	72	DEVSEL#	I/O
73	C/BE1#	I/O	74	GND	-
75	AD14	I/O	76	AD15	I/O
77	GND	-	78	AD13	I/O
79	AD12	I/O	80	AD11	I/O
81	AD10	I/O	82	GND	-
83	GND	-	84	AD09	I/O
85	AD08	I/O	86	C/BE0#	I/O
87	AD07	I/O	88	+3.3V	0
89	+3.3V	0	90	AD06	I/O
91	AD05	I/O	92	AD04	I/O
93	NC	-	94	AD02	I/O
95	AD03	I/O	96	AD00	I/O
97	+5VS_MINIPCI	0	98	NC	-
99	AD01	I/O	100	NC	-
101	GND	-	102	GND	-
103	NC	-	104	NC	-
105	NC	-	106	NC	-
107	NC	-	108	NC	-
109	NC	-	110	NC	-
111	NC	I	112	NC	-
113	GND	-	114	GND	-
115	NC	-	116	NC	-
117	GND	-	118	GND	-
119	GND	-	120	GND	-
121	NC	-	122	NC	-
123	+5VS_MINIPCI	-	124	+3.3V	-

Table C-8 Mini PCI I/F pin assignments (124-pin)(2/2)

Terminal No.	Symbol	Function
1	Vss	GND
2	V _{DD}	POWER SUPPLY : +3.3V
3	V _{DD}	POWER SUPPLY : +3.3V
4	VEDID	DDC 3.3V POWER SUPPLY : +3.3V
5	NC	Non-Connection
6	CLKEDID	DDC Clock
7	DATAEDID	DDC Data
8	RxOIN0-	Negative LVDS differential data input (Odd), [R0-R5, G0]
9	RxOIN0+	Positive LVDS differential data input (Odd), [R0-R5, G0]
10	Vss	GND
11	RxOIN1-	Negative LVDS differential data input (Odd), [G1-G5, B0-B1]
12	RxOIN1+	Positive LVDS differential data input (Odd), [G1-G5, B0-B1]
13	Vss	GND
14	RxOIN2-	Negative LVDS differential data input (Odd), [B2-B5, HS, VS, DE]
15	RxOIN2+	Positive LVDS differential data input (Odd), [B2-B5, HS, VS, DE]
16	Vss	GND
17	RxOCLKIN-	Negative LVDS differential clock input (Odd)
18	RxOCLKIN+	Positive LVDS differential clock input (Odd)
19	Vss	GND
20	RxEIN0-	Negative LVDS differential data input (Even), [R0-R5, G0]
21	RxEIN0+	Positive LVDS differential data input (Even), [R0-R5, G0]
22	Vss	GND
23	RxEIN1-	Negative LVDS differential data input (Even), [G1-G5, B0-B1]
24	RxEIN1+	Positive LVDS differential data input (Even), [G1-G5, B0-B1]
25	Vss	GND
26	RxEIN2-	Negative LVDS differential data input (Even), [B2-B5, HS, VS, DE]
27	RxEIN2+	Positive LVDS differential data input (Even), [B2-B5, HS, VS, DE]
28	Vss	GND
29	RxECLKIN-	Negative LVDS differential clock input (Even)
30	RxECLKIN+	Positive LVDS differential clock input (Even)

	Pin No.
P1	5in1-GND
P2	SM-CD-COM
PЭ	SM-CO-SW
P4	
P\$	SD-WP-SW
P6	SD-DATI
P7	50-0470
P8	SD-CLK
P9	SD-VCC
P10	SD-CMD
P17	50-0473
P12	SD-DAT2
P1J	MS-85
P14	MS-DATA1
P15	MS-DATAO
P16	MS-DATA2
P17	MS-INS
P18	MS-DATA3
	MS-SCLK
P20	
P21	S.H./xD-D4
	S.M/xD-05
	S.M/xD-06
	5.M/xD-D7
P25	S.M-LVD
P26	#5.M/xD-R/8
	#S.M/XD-RE
	#S.M/xD-CE
	S.M/xD-VCC
P30	∦S.M—CD
_	S.M/xD-DZ
P33	
P34	S.M-D0
P35	S.M/xD-WP-W
P36	#S.M/XD-WE
P37	#S.M/xD-ALE
P 38	
P39	xD-CD
P40	л0-VCC
P41	
	SD-CD-SW
	SM-WP-SW
PAA	5in1-GND

Pin No.	Signal name	I/O	Pin No.	Signal Name	I/O
1	FAN1	I	2	FAN-SPEED1	0
3	GND	-			

Table C-9-1 JP18 Fan I/F pin assignments (3-pin)

Table C-9-2 JP21 Fan I/F pin assignments (3-pin)

Pin No.	Signal name	I/O	Pin No.	Signal Name	I/O
1	FAN2	I	2	FAN-SPEED2	0
3	GND	-			

C.11 PJP1

Table C-10 AC Adaptor Connector pin assignments (3-pin)

Pin No.	Signal name	I/O	Pin No.	Signal Name	I/O
1	VIN	I	2	GND	-
3	GND	-	4	GND	-
5	GND	-	6	GND	-

C.12 JP16

Pin No.	Signal name	I/O	Pin No.	Signal Name	I/O
1	ANGND	-	2	MIC	I
3	BIAS	I	4	NC	-
5	NC	-	6	ANGND	-

Table C-12 Microphone I/F pin assignments (6-pin)

C.13 JP17

Table C-14 Headphone Connector pin assignments (6-pin)

Pin No.	Signal name	I/O	Pin No.	Signal Name	I/O
1	ANGND	-	2	INTSPK_L1	0
3	INTSPK_R1	0	4	NBA_PLUG	I
5	ANGND	-	6	NC	-

Appendix D Keyboard Scan/Character Codes

Сар	Kasatan	Code set 1		Code set 2			Nata
No.	Keytop	Make	Break	Make	Break		Note
01	'~	29	A9	0E	F0	0E	
02	1!	02	82	16	F0	16	
03	2@	03	83	1E	F0	1E	
04	3 #	04	84	26	F0	26	
05	4 \$	05	85	25	F0	25	
06	5 %	06	86	2E	F0	2E	
07	6 ^	07	87	36	F0	36	
08	7&	08	88	3D	F0	3D	*2
09	8 *	09	89	3E	F0	3E	*2
10	9 (0A	8A	46	F0	46	*2
11	0)	0B	8B	45	F0	45	
12		0C	8C	4E	F0	4E	
13	= +	0D	8D	55	F0	55	
15	BkSp	0E	8E	66	F0	66	
16	Tab	0F	8F	0D	F0	0D	
17	Q	10	90	15	F0	15	
18	W	11	91	1D	F0	1D	
19	E	12	92	24	F0	24	
20	R	13	93	2D	F0	2D	
21	Т	14	94	2C	F0	2C	
22	Y	15	95	35	F0	35	
23	U	16	96	3C	F0	3C	*2
24	I	17	97	43	F0	43	*2
25	0	18	98	44	F0	44	*2
26	Р	19	99	4D	F0	4D	*2
27	[{	1A	9A	54	F0	54	
28] }	1B	9B	5B	F0	5B	

Table D-1 Scan codes (set 1 and set 2) (1/4)

Сар	Keytop	Code set 1		Code set 2			Note
No.		Make	Break	Make	Bre	eak	Note
29	\	2B	AB	5D	F0	5D	*5
30	Caps Lock	ЗA	BA	58	F0	58	
31	А	1E	9E	1C	F0	1C	
32	S	1F	9F	1B	F0	1B	
33	D	20	A0	23	F0	23	
34	F	21	A1	2B	F0	2B	
35	G	22	A2	34	F0	34	
36	Н	23	A3	33	F0	33	
37	J	24	A4	3B	F0	3B	*2
38	К	25	A5	42	F0	42	*2
39	L	26	A6	4B	F0	4B	*2
40	;:	27	A7	4C	F0	4C	*2
41	٤ ٤٤	28	A8	52	F0	52	
43	Enter	1C	9C	5A	F0	5A	*3
44	Shift (L)	2A	AA	12	F0	12	
45	No.102 key	56	D6	61	F0	61	
46	Z	2C	AC	1A	F0	1A	
47	Х	2D	AD	22	F0	22	
48	С	2E	AE	21	F0	21	
49	V	2F	AF	2A	F0	2A	
50	В	30	B0	32	F0	32	
51	Ν	31	B1	31	F0	31	
52	М	32	B2	3A	F0	3A	*2
53	, <	33	B3	41	F0	41	*2
54	. >	34	B4	49	F0	49	*2
55	/ ?	35	B5	4A	F0	4A	*2
57	Shift (R)	36	B6	59	F0	59	

Table D-1 Scan codes (set 1 and set 2) (2/4)

Сар	Keytop		Code	set 1			C	code s	et 2		Note
No.	Reytop	Ма	ake	Br	eak	Ma	ake		Brea	k	Note
58	Ctrl(L)	1	D	g	D	1	14	F0)	14	*3
60	Alt (L)	3	38	E	38	-	11	FO)	11	*3
61	Space	3	39	E	39	2	29	FO)	29	
62	ALT (R)	E0	38	E0	B8	E0	11	E0	F0	11	
64	Ctrl(R)	E0	1D	E0	9D	E0	14	E0	F0	14	
75	Ins	E0	52	E0	D2	E0	70	E0	F0	70	*1
76	Del	E0	53	E0	D3	E0	71	E0	F0	71	*1
79	\leftarrow	E0	4B	E0	СВ	E0	6B	E0	F0	6B	*1
80	Home	E0	47	E0	C7	E0	6C	E0	F0	6C	*1
81	End	E0	4F	E0	CF	E0	69	E0	F0	69	*1
83	\uparrow	E0	48	E0	C8	E0	75	E0	F0	75	*1
84	\downarrow	E0	50	E0	D0	E0	72	E0	F0	72	*1
85	PgUp	E0	49	E0	C9	E0	7D	E0	F0	7D	*1
86	PgDn	E0	51	E0	D1	E0	7A	E0	F0	7A	*1
89	\rightarrow	E0	4D	E0	CD	E0	74	E0	F0	74	*1
110	Esc		01		81		76	F0		76	
112	F1	:	3B	I	BB		05	F0		05	
113	F2	:	3C	I	BC		06	F0		06	
114	F3	:	3D	I	BD		04	F0		04	
115	F4	:	3E	I	BE		0C	F0		0C	
116	F5	:	3F		BF		03	F0		03	
117	F6		40		C0		0B	F0		0B	
118	F7		41		C1		83	F0		83	
119	F8		42		C2		0A	F0		0A	
120	F9		43		C3		01	F0		01	
121	F10		44		C4		09	F0		09	*3

Table D-1 Scan codes (set 1 and set 2) (3/4)

Сар	Keytop		Code	set 1			C	ode s	set 2		Note
No.	Neytop	Ма	ke	Br	eak	Ма	ake		Break		NOLE
122	F11	57		D7		78		F0	78		*3
123	F12	58		D8		07		F0	07		*3
124	PrintSc	*6		*6		*6		*6			*6
126	Pause	*7		*7		*7		*7			*7
Х	Fn	—		—		—		—			*4
Х	Win	E0	5B	E0	DB	E0	1F	E0	F0	1F	
x	Арр	E0	5D	E0	DD	E0	2F	E0	F0	2F	

Table D-1 Scan codes (set 1 and set 2) (4/4)

Notes:

- 1. * Scan codes differ by mode.
- 2. * Scan codes differ by overlay function.
- 3. * Combination with the **Fn** key gives different codes.
- 4. * The **Fn** key does not generate a code by itself.
- 5. * This key corresponds to key No. 42 in a 102-key model.
- 6. * Refer to Table D-6, No. 124 key scan code.
- 7. * Refer to Table D-7, No. 126 key scan code.

Сар	Key			C	Code	set '	1						(Code	set 2	2			
No.	top		Ма	ke			Bre	ak				Make)			I	Breal	k	
55	/	E0	AA	E0	35	E0	B5	E0	2A	E0	F0	12	E0	4A	E0	F0	4A	E0	12
75	INS	E0	AA	E0	52	E0	D2	E0	2A	E0	F0	12	E0	70	E0	F0	70	E0	12
76	DEL	E0	AA	E0	53	E0	D3	E0	2A	E0	F0	12	E0	71	E0	F0	71	E0	12
79	\leftarrow	E0	AA	E0	4B	E0	СВ	E0	2A	E0	F0	12	E0	6B	E0	F0	6B	E0	12
80	Home	E0	AA	E0	47	E0	C7	E0	2A	E0	F0	12	E0	6C	E0	F0	6C	E0	12
81	End	E0	AA	E0	4F	E0	CF	E0	2A	E0	F0	12	E0	69	E0	F0	69	E0	12
83	\uparrow	E0	AA	E0	48	E0	C8	E0	2A	E0	F0	12	E0	75	E0	F0	75	E0	12
84	\downarrow	E0	AA	E0	50	E0	D0	E0	2A	E0	F0	12	E0	72	E0	F0	72	E0	12
85	PgUp	E0	AA	E0	49	E0	C9	E0	2A	E0	F0	12	E0	7D	E0	F0	7D	E0	12
86	PgDn	E0	AA	E0	51	E0	D1	E0	2A	E0	F0	12	E0	7A	E0	F0	7A	E0	12
89	\rightarrow	E0	AA	E0	4D	E0	CD	E0	2A	E0	F0	12	E0	74	E0	F0	74	E0	12
х	Win	E0	AA	E0	5B	E0	DB	E0	2A	E0	F0	12	E0	1F	E0	F0	1F	E0	12
х	Арр	E0	AA	E0	5D	E0	DD	E0	2A	E0	F0	12	E0	2F	E0	F0	2F	E0	12

Table D-2 Scan codes with left Shift key

Note : The table above shows scan codes with the left **Shift** key. In combination with the right **Shift** key, scan codes are changed as listed below:

	With left Shift	With right Shift
Set 1	E0 AA	E0 B6
	E0 2A	E0 36
Set 2	E0 F0 12	E0 F0 59
	E0 12	E0 59

Сар	Key		Code set 1									C	Code	set	2				
No.	top		Ма	ike			Br	eak			Ma	ake				Bre	eak		
75	INS	E0	2A	E0	52	E0	D2	E0	AA	E0	12	E0	70	E0	F0	70	E0	F0	12
76	DEL	E0	2A	E0	53	E0	D3	E0	AA	E0	12	E0	71	E0	F0	71	E0	F0	12
79	←	E0	2A	E0	4B	E0	СВ	E0	AA	E0	12	E0	6B	E0	F0	6B	E0	F0	12
80	Home	E0	2A	E0	47	E0	C7	E0	AA	E0	12	E0	6C	E0	F0	6C	E0	F0	12
81	End	E0	2A	E0	4F	E0	CF	E0	AA	E0	12	E0	69	E0	F0	69	E0	F0	12
83	\uparrow	E0	2A	E0	48	E0	C8	E0	AA	E0	12	E0	75	E0	F0	75	E0	F0	12
84	\downarrow	E0	2A	E0	50	E0	D0	E0	AA	E0	12	E0	72	E0	F0	72	E0	F0	12
85	PgUp	E0	2A	E0	49	E0	C9	E0	AA	E0	12	E0	7D	E0	F0	7D	E0	F0	12
86	PgDn	E0	2A	E0	51	E0	D1	E0	AA	E0	12	E0	7A	E0	F0	7A	E0	F0	12
89	\rightarrow	E0	2A	E0	4D	E0	CD	E0	AA	E0	12	E0	74	E0	F0	74	E0	F0	12
х	Win	E0	2A	E0	5B	E0	DB	E0	AA	E0	12	E0	1F	E0	F0	1F	E0	F0	12
Х	Арр	E0	2A	E0	5D	E0	DD	E0	AA	E0	12	E0	2F	E0	F0	2F	E0	F0	12

Table D-3 Scan codes in Numlock mode

Table D-4 Scan codes with Fn key

Сар			Code	set 1			C	ode se	t 2	
No.	Keytop	N	lake	В	reak	М	ake		Break	
43	ENT	E0	1C	E0	9C	E0	5A	E0	F0	5A
58	L-CTRL	E0	1D	E0	9D	E0	14	E0	F0	14
60	L-ALT	E0	38	E0	B8	E0	11	E0	F0	11
121	ARROW		45		C5	-	77	F	7 (77
122	NUMERIC	45			C5	77		F	7 (77
123	Scrl		46		C5		7E	F) 7	Έ

Сар	Ko	ytop		Cod	e set 1			C	ode se	t 2	
No.	Ne.	уюр	Ма	ake	Bre	eak	Ма	ke		Break	
09	8	(8)	4	8	С	8	7	5	F0		75
10	9	(9)	4	9	С	9	7	D	F0		7D
11	0	(*)	3	37	В	7	7	С	F0		7C
23	U	(4)	4	·B	С	В	6	В	F0		6B
24	Ι	(5)	4	C	С	С	7	3	F0		73
25	0	(6)	4	D	С	D	7	4	F0		74
26	Р	(-)	4	A	С	A	7	В	F0		7B
37	J	(1)	4	F	С	F	6	9	F0		69
38	к	(2)	5	50	D	0	7	2	F0		72
39	L	(3)	5	51	D	1	7.	A	F0		7A
40	;	(+)	4	·Ε	С	Е	7	9	F0		79
52	М	(0)	5	52	D	2	7	0	F0		70
54		(.)	5	53	D	3	7	1	F0		71
55	/	(/)	E0	35	E0	B5	40	4A	E0	F0	4A

 Table D-5
 Scan codes in overlay mode

Table D-6 No.124 key scan code

Key	Shift				Code	e set '	1							Code	set :	2			
top	Shint		Ма	ke			Br	eak			Ma	ake				Br	eak		
Prt Sc	Common	E0	2A	E0	37	E0	Β7	E0	AA	E0	12	E0	7C	E0	F0	7C	E0	F0	12
	Ctrl +		E0	37			E0	B7			E0	7C			E0	F0	7C		
	Shift +		E0	37			E0	B7			E0	7C			E0	F0	7C		
	Alt +			54			D4					84			F0	B4			

Table D-7 No.126 key scan code

Key top	Shift			Code	set 1						Code	set 2	2		
				Ма	ke						Ма	ake			
Pause	Common	E1	1D	45	E1	9D	C5	E1	14	77	E1	F0	14	F0	77
	Ctrl	E0	46	E0	C6			E0	7E	E0	F0	7E			

*: This key generates only make codes.

Appendix E Key Layout

E.1 United States (US) Keyboard



Figure E-1 US keyboard

E.2 United Kingdom (UK) Keyboard



Figure E-2 UK keyboard

E.3 Spanish (SP) Keyboard



Figure E-3 SP keyboard

E.4 Japanese (JA) Keyboard



Figure E-4 JA keyboard

E.5 Korean (KO) Keyboard



Figure E-5 KO keyboard

E.6 Korean (CF) Keyboard



Figure E-6 CF keyboard

E.7 Portuguese-ALPS Keyboard



Figure E-7 Portuguese-ALPS keyboard

E.8 US-INTE_ALPS Keyboard



Figure E-8 US-INTE_ALPS Keyboard

E.9 Greece(GR) Keyboard



Figure E-9 GR keyboard

E.10 France (FR) Keyboard



Figure E-10 FR keyboard

E.11 Chinese (CH) Keyboard



Figure E-11 CH keyboard





Figure E-12 Swissc-Darfon keyboard

E.13 IT new Keyboard

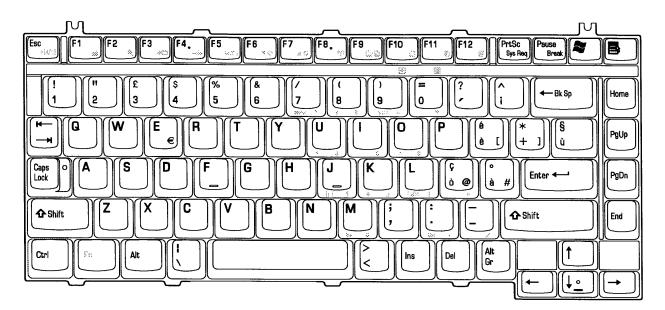


Figure E-13 IT new keyboard

Appendix F Series Screw Torque List

SCREW P/N	SCREW SPEC	Q'ty	LOCATION	SCREW TORQUE
MAAA0015320	M2*3	6	LCD BRK TO LCDPANEL	1.2~1.5kg
MAAA0015320	M2*3	1	INVERTER TO COVER SUB ASSY	1.5~2.0kg
MAAA0015320	M2*3	1	LCD CABLE TO COVER SUB ASSY	1.5~2.0kg
MAC925003Z0	M2.5*3	1	LCD CABLE TO LOG UP	2.5~3.0kg
MMCK25050Z0	M2.5*5	2	LCD BRK ASSY TO COVER SUB ASSY(R+L)	2.5~3kg
MMCK25050Z0	M2.5*5	2	LCD BEZEL ASSY TO COVER SUB ASSY	2.5~3kg
MAC925003Z0	M2.5*3	2	KEYBOARD TO LOGIC ASSY	2.5~3.0kg
MMCK20050N0	M2*5	2	CARD BUS TO MB	1.5~2.0kg
MAAA0051400	M2*7	2	Card Bus to MB	1.5~2.0kg
MACK20003Z0	M2*13	2	HDD CONNT TO MB	1.5~2.0kg
MMCK20050N0	M2*5	2	CD ROM CONN TO MB	1.5~2.0kg
MAC925003Z0	M2.5*3	2	MDC TO MB	2.5~3kg
MACK25080Z0	M2.5*8	2	MB TO LOG LOWER	2.5~3kg
MAC925003Z0	M2.5X3	1	TRACK PAD BRK TO LOGIC UPPER	2.5~3kg
MMCK25030N0	M2.5X3	2	LED BOARD TO LOG UP	2.5~3kg
MMCK25050Z0	M2.5*5	2	SADDLE(R/L) TO LOG UP SHIELD TO LOG UP	2.5~3kg
MAAA0015320	M2.0X3	4	SPEAKER L/R TO LOGIC UPPER	1.5~2kg
MAC925003Z0	M2.5*3	1	LOGIC UPPER TO STANDOFF TO MB	2.5~3kg
MACK25080Z0	M2.5*8	5	LOGIC UPPER TO LOG LOWER	2.5~3kg
MACK25080Z0	M2.5*8	2	LOG LOW-TO HINGE SADDLE R(L)	2.5~3kg
MACK25080Z0	M2.5*8	14	LOGIC LOWER TO LOGIC UPPER	2.5~3kg
MAC925003Z0	M2.5*3	2	LOGIC LOWER TO LOGIC UPPER	2.5~3kg

Table F-1 Series Screw Torque List

SCREW P/N	SCREW SPEC	Q'ty	LOCATION	SCREW TORQUE
MMCK25080Z0	M2.5*8	1	LOG LOW TO ODD MODULE	2.5~3kg
MACK25080Z0	M2.5*8	2	LCD HINGE BRK R(L)-TO-HINGE SADDLE R(L)	4~4.5kg
ECBL104M000	M2.5*5 半牙	1	RAM DOOR TO LOGIC LOWER	2.5~3kg
MMCK25050Z0	M2.5*5	2	HDD DOOR TO LOGIC LOWER	2.5~3kg
ECBL104M000 or ECTQ007L000	M2.5*5 半牙 or M2.5*5 半牙(梅花)	1	MINIPCI BRACKET TO LOGIC LOWER	2.5~3kg
MAFA94001N0	4.75*9.6	2	VGA PORT TO LOGIC ASSY	2.5~3kg
MAFA94001N0	4.75*9.6	2	PRINT PORT TO LOGIC ASSY	2.5~3kg
MMCK20050N0	M2*5	4	THERMAL-FAN	1.5~2.0kg
MACW108H000	SPECIAL SCREW	4	THERMAL MODULE	2.0~2.5kg
MMCK25050Z0	M2.5*5	1	BATTERY LATCH TO LOG LOW	2.5~3kg
MAAA4303000	M3*3	4	HDD BRACKET L/R TO HDD MODULE	2.0~2.5kg
MAAA0015320	M2*3	2	MODULE LOCK BRACKET TO XDROM MODULE	1.5~2.0kg

Appendix G Reliability

The following table shows MTBF (Mean Time Between Failures) for each component.

Table G-1 MTBF

Component	Time (hours)
LCD	50,000
Keyboard	40,000
HDD	300,000
Removable FDD	30,000
Optical (DVD/CD) drive	60,000
AC adaptor	60,000